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# Basic 7

# Micro-Nano Assembly

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# Contents

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1. Introduction

2. Interaction force in micro-nano world

3. Elemental techniques

Micro-nano manipulation

Connection

Self-assembly

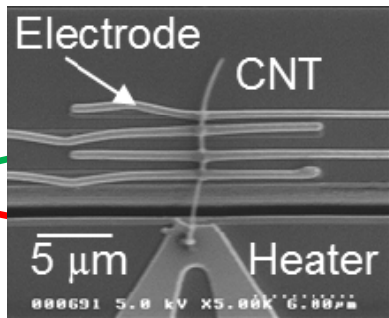
4. Summary



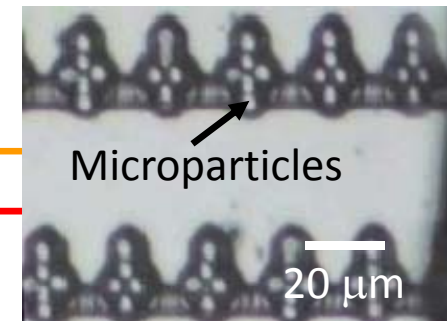
# Techniques for Micro-Nano Assembly

## Micro-Nano Manipulation

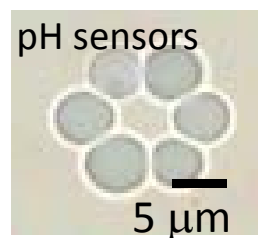
- Contact (Mechanical, Electrostatic, Wan der Waals, etc.)
- Noncontact (Optical, Electrostatic, Magnetic, etc. )



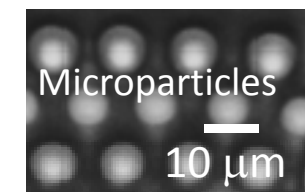
## Micro-Nano Assembly



- Self-adhesive material
- Optical connection
- Welding



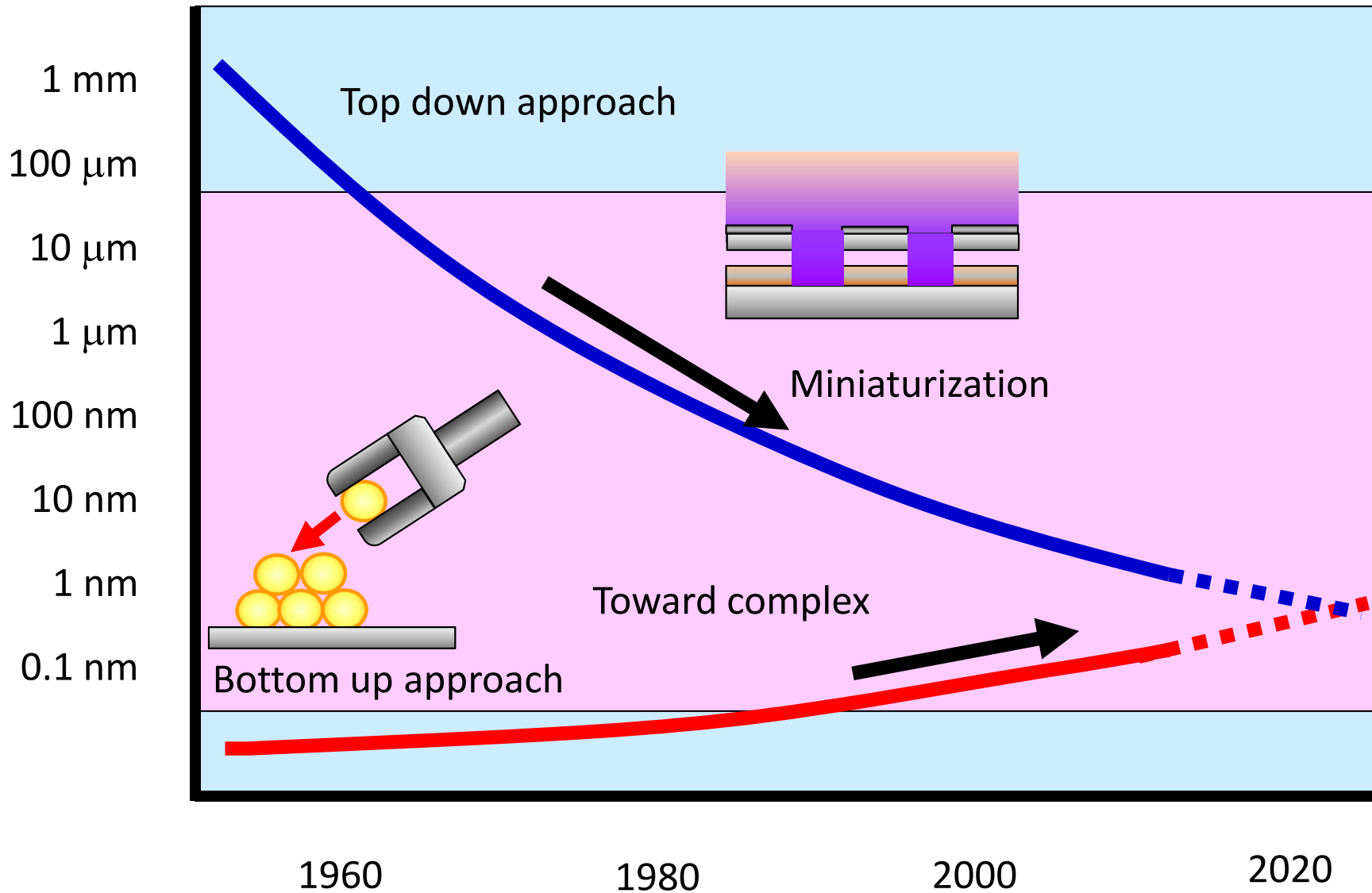
- Chemical and Physical
- Physical
- Chemical



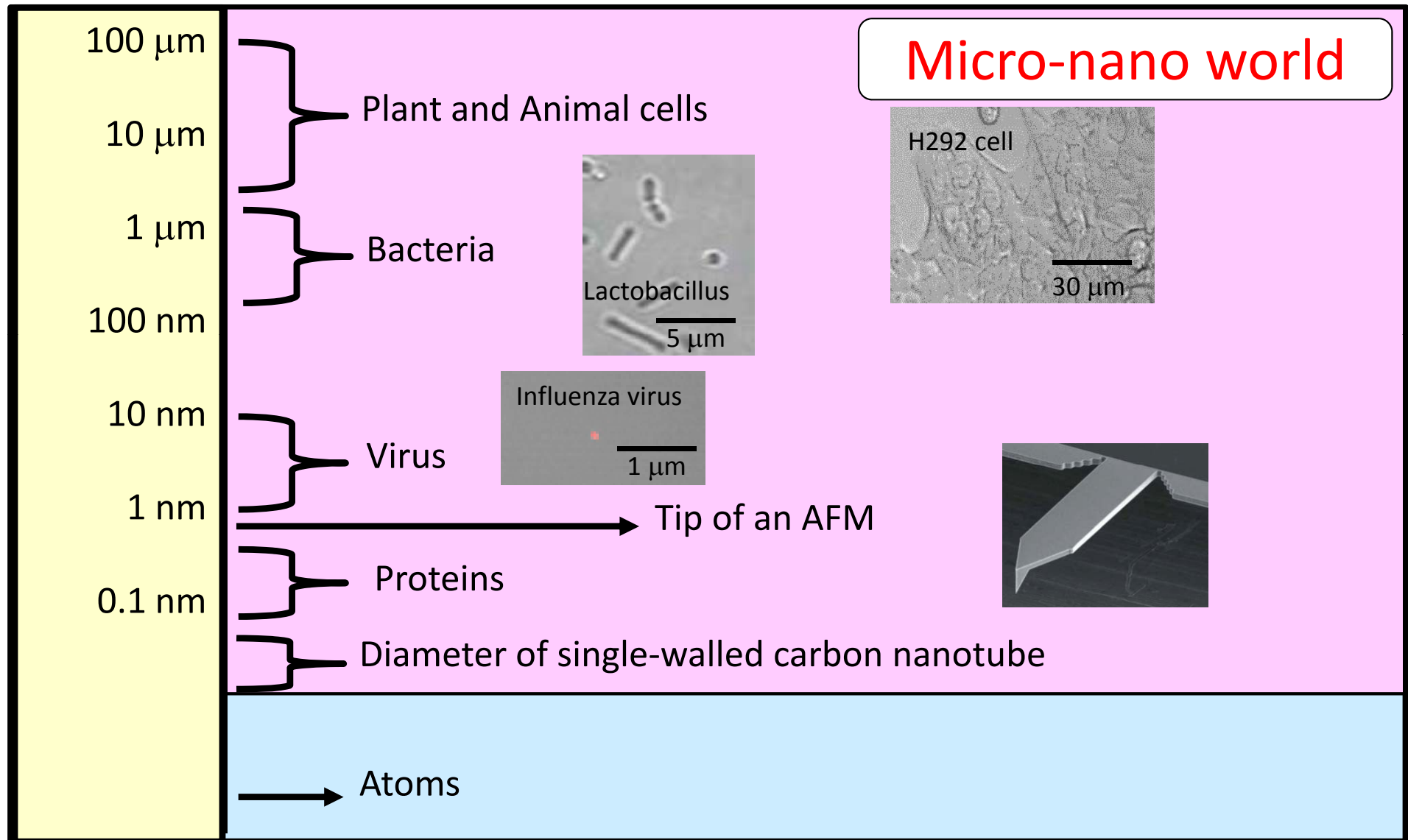
## Connection

## Self-assembly

# Approach of Micro-Nano Technology



# Size and scale of structures in Micro-Nano World

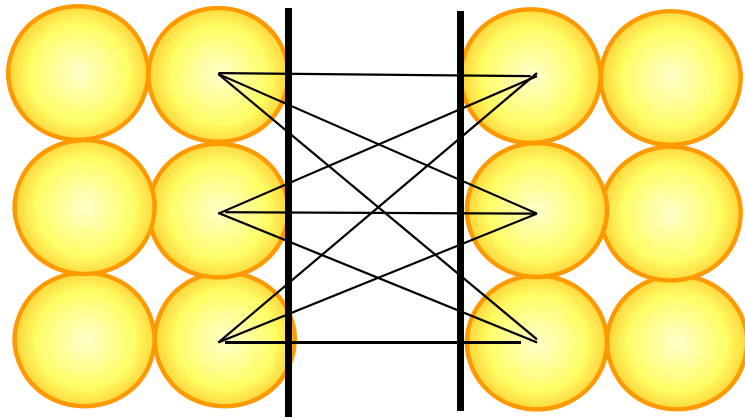


# Comparison of Workspace (Microscope)

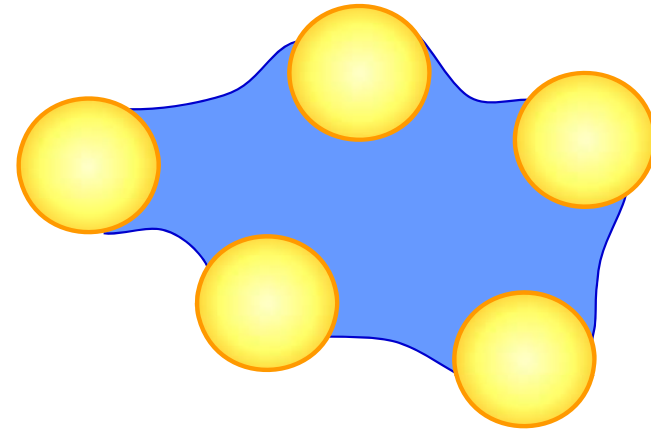
Properties	Items	AFM	STM	SEM	OM
Manipulation	Interaction with object	Contact Noncontact Intermittent contact	noncontact	Noncontact	Noncontact
Imaging	Imaging principle	Interatomic force	Tunneling current	Electron emission	Light-matter interaction
	Visual resolution	> 0.1 nm	> 0.1 nm	> 1 nm	> 100 nm
	Objective type	All	Conductor Semi-conductor	Conductor Semi-conductor	All
	Dimensions	3D	3D	2D	2D
Real-time sensing		Force/image	Image	Image	Image

# Interactive Force in Micro-Nano Word

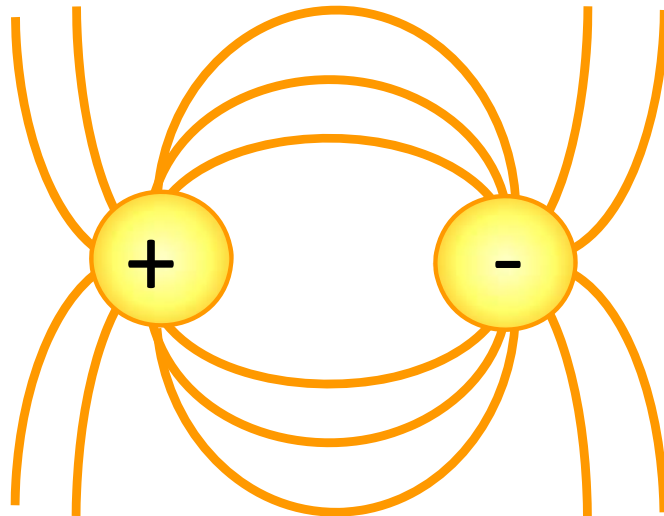
(a) Van der Waals force



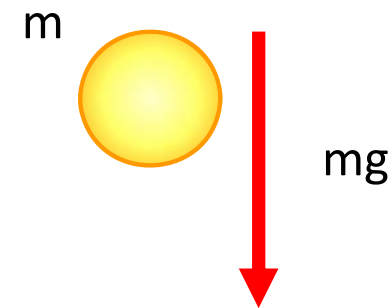
(b) Liquid bridge force



(c) Electric force



(d) Gravity force



# Wan der Waals Force

Energy of interaction between atoms (ex. Dispersion effect)

$$\mathcal{E} = -\frac{\Lambda}{z^6}$$

$z$ : distance between atoms

$\Lambda$ : London-wan der Waals constant

Energy of interaction between particles

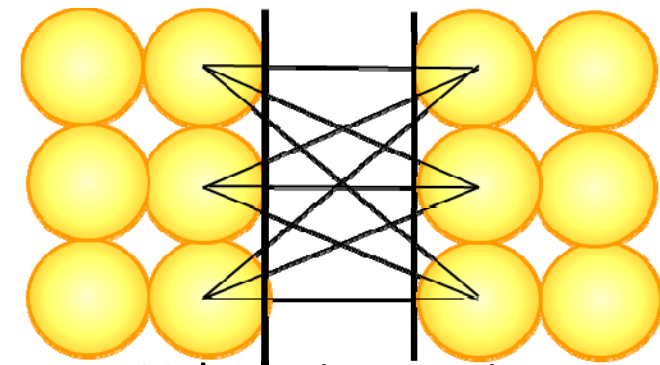
$$E = -\int_{V_1} d\tau_1 \int_{V_2} d\tau_2 \frac{n^2 \Lambda}{z^6}$$

$V_1, V_2$ : volume of particles

$n$ : number of atoms

Van der wals force

$$F_{vdw} = \frac{\partial E}{\partial z}$$



Volume integration



# Van der Waals Force

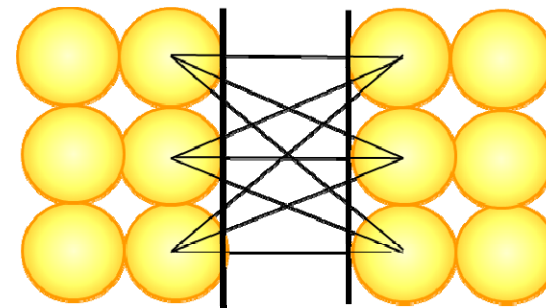
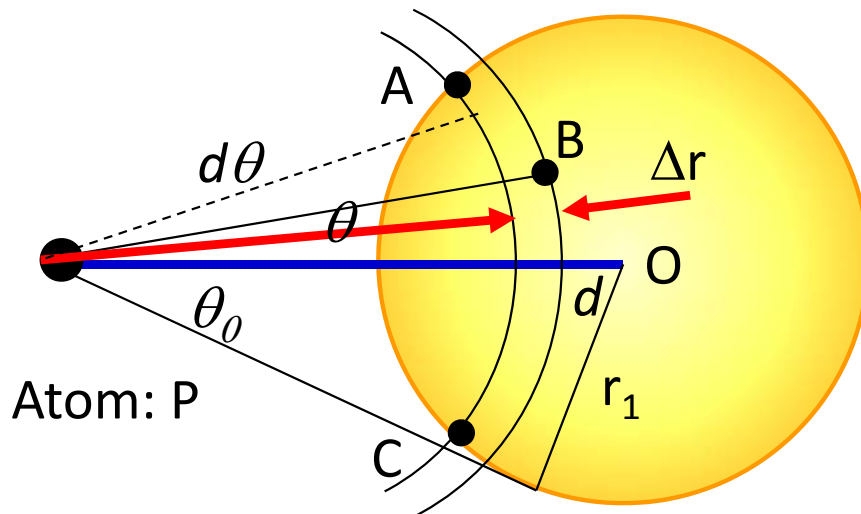
## 1. Theory of Hamaker

Interaction between two objects is acquired by adding interactions between all molecules.

## 2. Theory of Lifshitz

Interaction between molecules is followed by London force.

$$\varepsilon = -\frac{\Lambda}{z^6}$$



$$S_{ABC} = \frac{\pi r}{d} \left\{ r_1^2 - (d - r)^2 \right\}$$

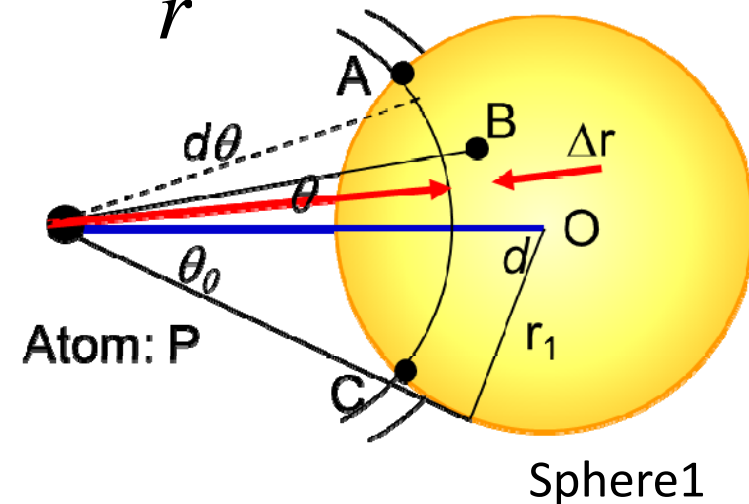
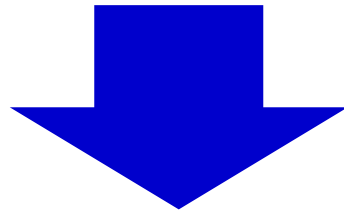
$$V_{ABC} = \frac{\pi r}{d} \left\{ r_1^2 - (d - r)^2 \right\} \Delta r$$

# Wan der Waals Force

Wan der Waals energy between  $V_{ABC}$  and P

$$E_{ABC-P} = \frac{\pi r}{d} \left\{ r_1^2 - (d - r)^2 \right\} \Delta r \cdot n \frac{\Lambda}{r^6}$$

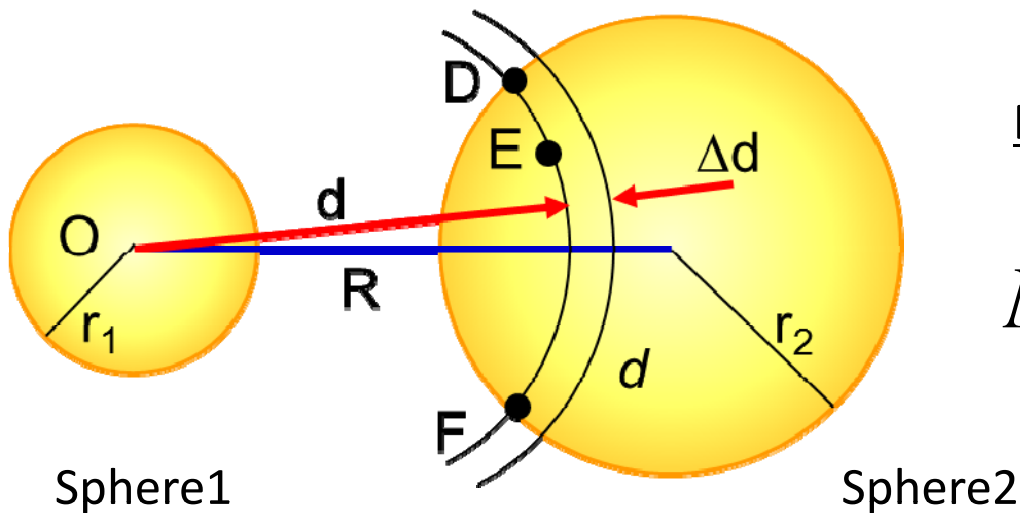
“n” per unit volume



Wan der Waals energy between Sphere1 and P

$$E_{1-P} = - \int_{d-r_1}^{d+r_1} \frac{\Lambda \pi n}{d} \cdot \frac{1}{r^5} \left\{ r_1^2 - (d - r)^2 \right\} \Delta r$$

# Wan der Waals Force



Number of atoms in  $V_{DEF}$

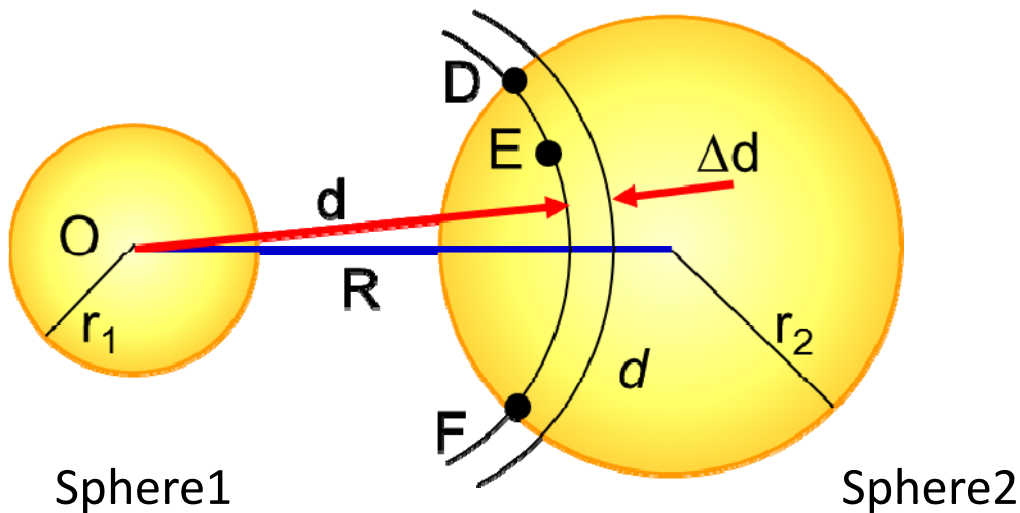
$$N_{VDEF} = \frac{\pi n d}{R} \left\{ r_2^2 - (R - d)^2 \right\} \Delta d$$

Wan der Waals energy between Sphere1 and Sphere2

$$E_{1-2} = - \int_{R-r_2}^{R+r_2} E_{1-P} \cdot n \pi \frac{d}{R} \left\{ r_2^2 - (R - d)^2 \right\} \Delta d$$

$$= - \int_{R-r_2}^{R+r_2} \int_{d-r_1}^{d+r_1} \left\{ r_1^2 - (d - r)^2 \right\} \left\{ r_2^2 - (R - d)^2 \right\} \Delta r \Delta d$$

# Wan der Waals Force



## Wan der Waals energy between Sphere1 and Sphere2

$$E_{1-2} = E_{vdw} = -\frac{H}{6} \left\{ \frac{2r_1r_2}{R^2 - (r_1 + r_2)^2} + \frac{2r_1r_2}{R^2 - (r_1 - r_2)^2} + \ln \frac{R^2 - (r_1 + r_2)^2}{R^2 - (r_1 - r_2)^2} \right\}$$

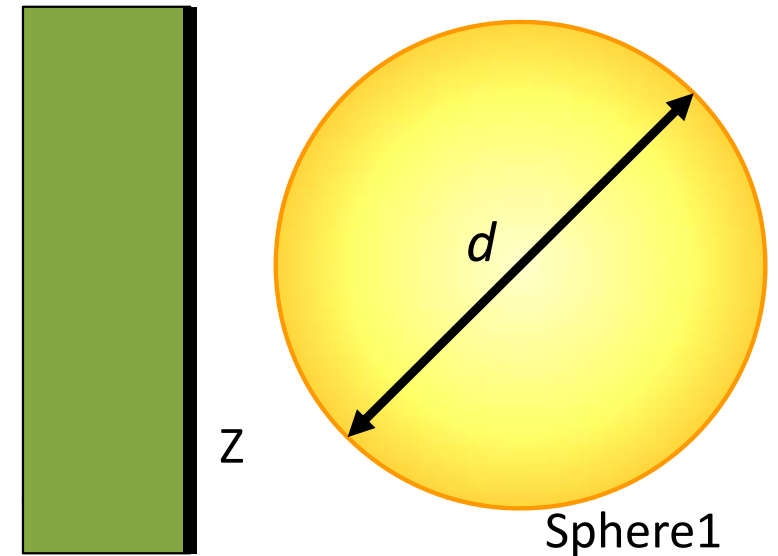
$$H = n^2 \pi^2 \Lambda \quad \text{Hamaker constant}$$

# Wan der Waals Force

$r_2 \rightarrow \infty$  "r<sub>1</sub>" is rewritten to "d"

Wan der Waals energy between Sphere1 and wall

$$E_{vdw} = -\frac{H}{6} \left\{ \frac{d}{2z} + \frac{d}{2(z+d)} + \ln \frac{z}{z+d} \right\}$$



Differentiate it with respect to z

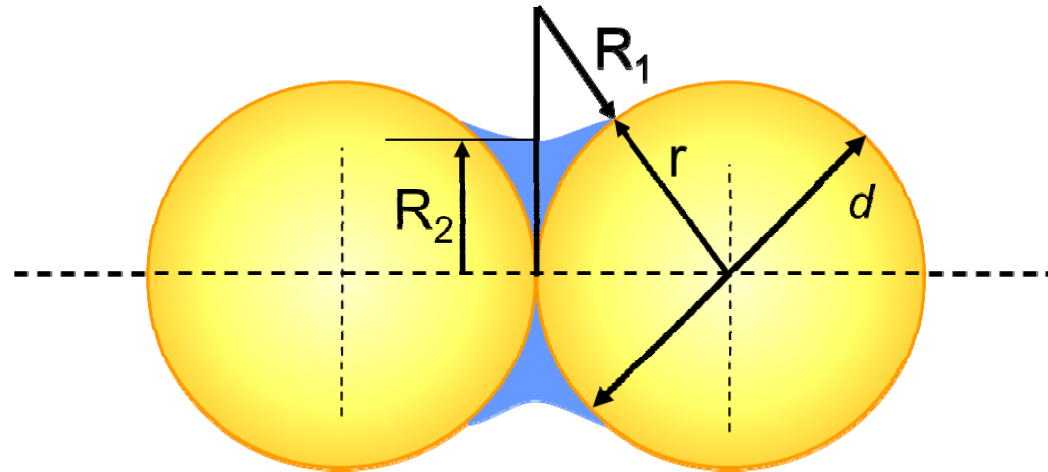
Wan der Waals force

(z << d)

$$E_{vdw} = -\frac{H}{6} \left\{ \frac{d}{2z} + \frac{1}{2} + \ln 0 \right\}$$

$$F_{vdw} \approx \frac{Hd}{12z^2}$$

# Liquid bridge force



$$\begin{cases} R_1 = r \left( \frac{1}{\cos \alpha} - 1 \right) \\ R_2 = r \cdot \tan \alpha - R_1 \end{cases}$$

Liquid bridge force (Positive if p is negative)

$$F_s = \pi R_2^2 \sigma \left( \frac{1}{R_1} - \frac{1}{R_2} \right) + 2\pi R_2 \sigma$$

$\sigma$ : Surface tension force

Capillary force effect:  
Haines, 1925

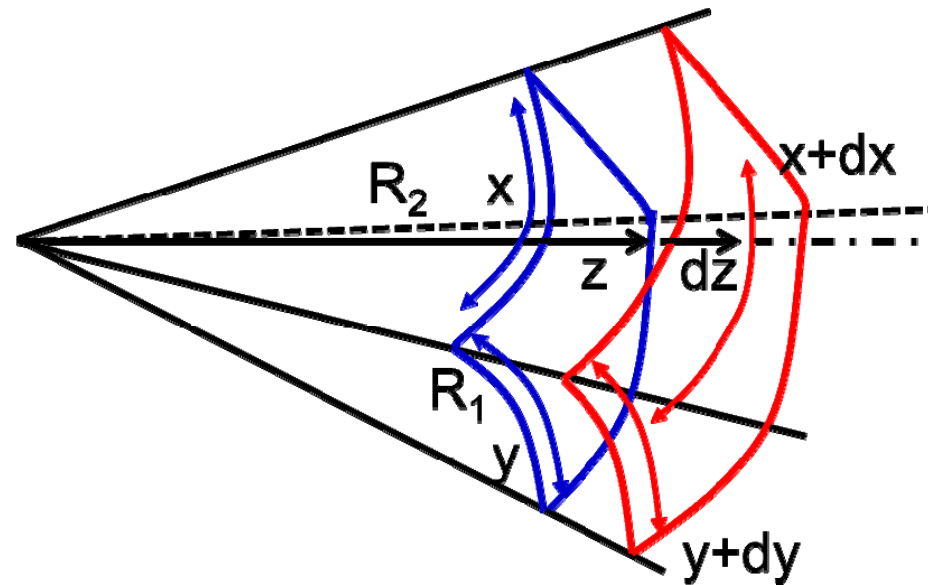
Surface tension effect  
Fisher, 1926

$$F_s = \frac{\pi d \sigma}{1 + \tan(\alpha / 2)}$$

$$\alpha \rightarrow 0$$

$$F_s = \pi d \sigma$$

# The Equation of Young and Laplace



The surface is dispersed a small distance outwards.

The change in area:

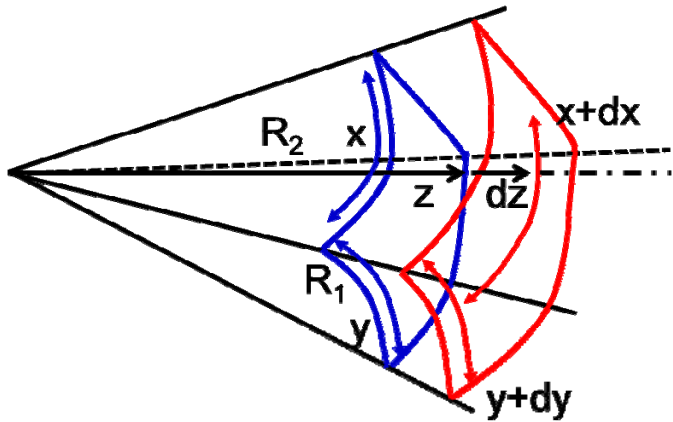
$$\Delta A = (x + dx)(y + dy) - xy = xdy + ydx$$

The work done in forming this amount of surface:

$$Work = \sigma \cdot \Delta A = \sigma(xdy + ydx) = \Delta Pxydz$$

$\sigma$ : Surface tension force,  $\Delta P$ : pressure difference

# The Equation of Young and Laplace



$$Work = \sigma \cdot \Delta A = \sigma(xdy + ydx) = \Delta Pxydz$$

$$\frac{x + dx}{R_2 + dz} = \frac{x}{R_2} \quad \text{or} \quad dx = \frac{xdz}{R_2}, \quad dxdz = 0$$

$$\frac{x + dx}{R_2 + dz} = \frac{x}{R_2} \quad \text{or} \quad dy = \frac{ydz}{R_2}, \quad dydz = 0$$

$$\Delta P = \frac{\sigma(xdy + ydx)}{xydz} = \sigma \left( \frac{dy}{ydz} + \frac{dx}{xdz} \right) = \sigma \left( \frac{1}{R_1} + \frac{1}{R_2} \right)$$



# Electrostatic force

## 1. Coulomb force

$$F_e = \frac{\pi \sigma_1 \sigma_2 d^2}{\epsilon_0}$$

$\epsilon_0$  Permittivity in vacuum

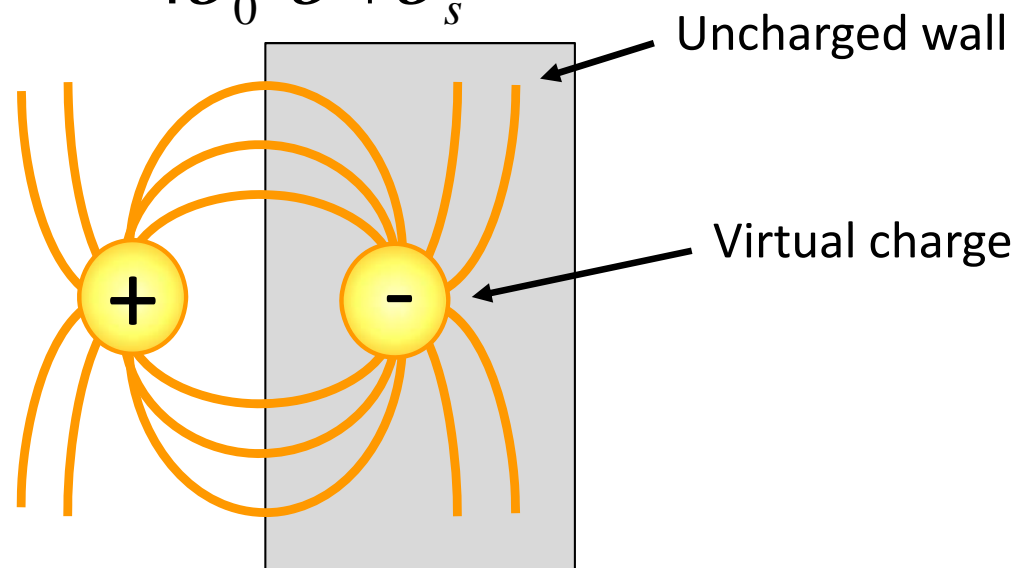
$\sigma_1, \sigma_2$  Surface charge density

$\epsilon$  Permittivity of object

## 2. Electric image force

$\epsilon_s$  Permittivity of solution

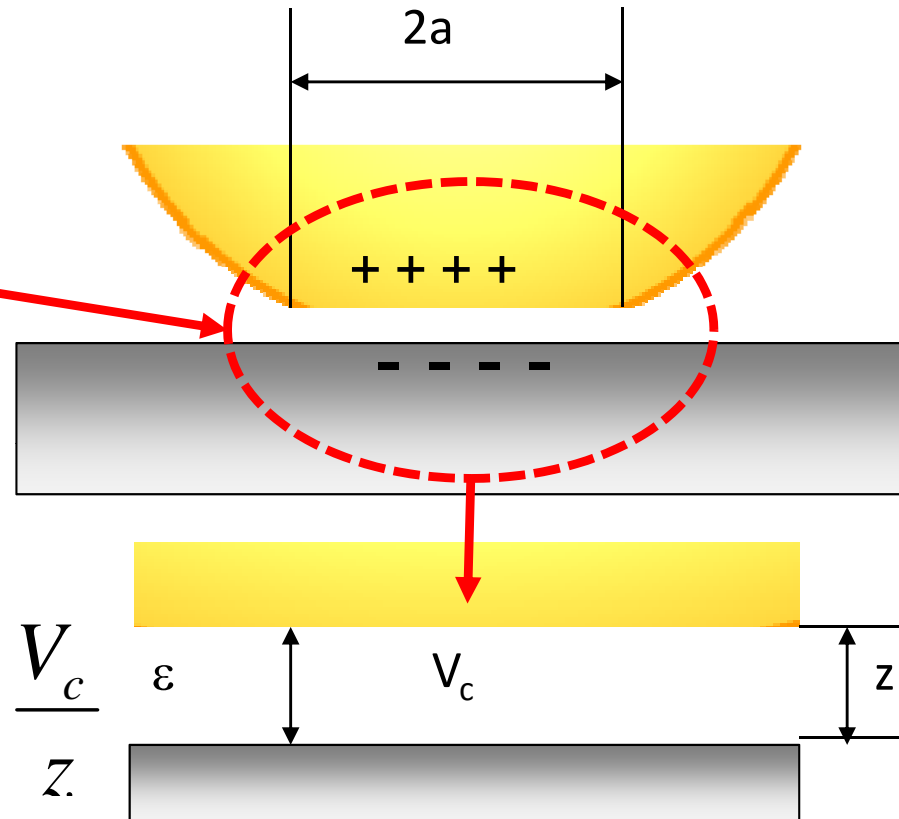
$$F_{ei} = \frac{\pi}{4\epsilon_0} \frac{\epsilon - \epsilon_s}{\epsilon + \epsilon_s} d^2 \sigma^2$$



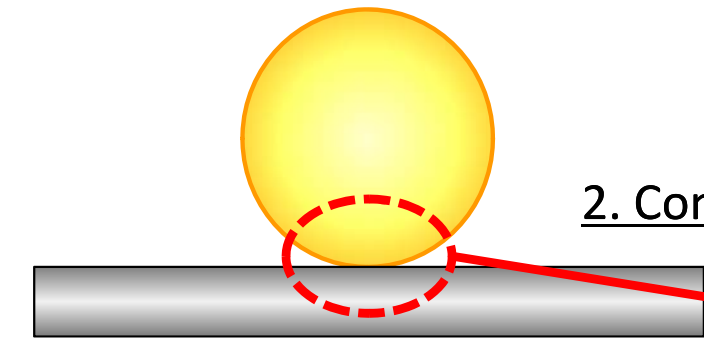
## 3. Contact charging

# Electrostatic force by Contact Charging

## 1. Deformed by interactive force



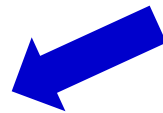
## 2. Contact charge



Electrostatic stress

$$P_{ce} = -\frac{1}{2} \epsilon E^2$$

$$P_{ce} = -\frac{\epsilon V_c^2}{2z^2}$$



$$E = \frac{V_c}{z}$$

$$S = \pi a^2$$

Hertz's constant stress theory

$$a = \left( \frac{3Fkd}{8} \right)^{\frac{1}{3}}$$

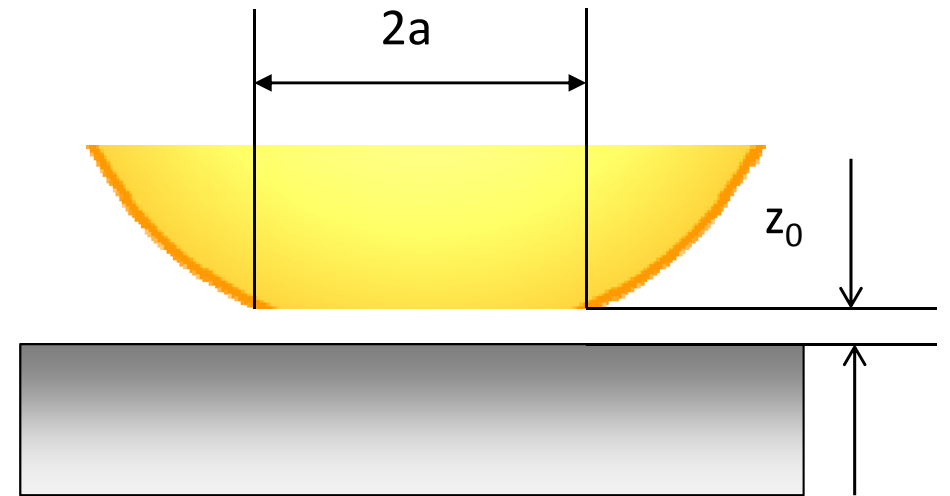
$$d = \frac{D_{p1} D_{p2}}{D_{p1} + D_{p2}}$$

$$k = \frac{1-\nu_1^2}{E_1} + \frac{1-\nu_2^2}{E_2}$$

# Electrostatic force by Contact Charging

Van der Waals force

$$F = -\left(\frac{Hd}{12z_0^2}\right) \cdot \left\{1 + \left(\frac{A^2 k^2}{108z_0^7}\right)d\right\}$$



Electrostatic force by constant charge

$$F_{ce} = P_{ce} S = P_{ce} \cdot \pi a^2 = P_{ce} \pi \left(\frac{3Fkd}{8}\right)^{\frac{2}{3}}$$

$$= -\frac{1}{2} \pi \epsilon_0 \frac{V_c^2}{z_0^2} \left\{ \frac{Akd^2}{z_0^2} \left(1 + \frac{A^2 k^2 d}{108z_0^7}\right) \right\}^{\frac{2}{3}}$$

# Dielectrophoresis

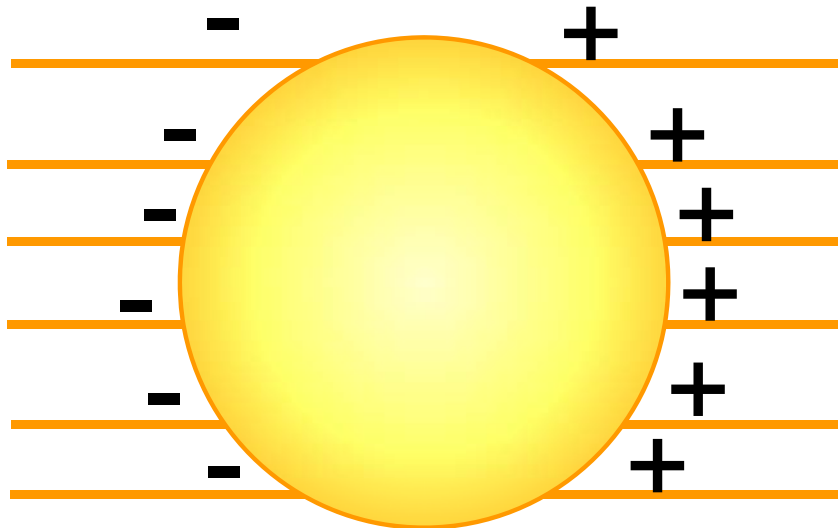
$$F_{dep} = \frac{1}{4} \pi d^3 \frac{\epsilon_0 (\epsilon - \epsilon_0)}{\epsilon + 2\epsilon_0} \nabla |E|^2$$

$E$  Electric field

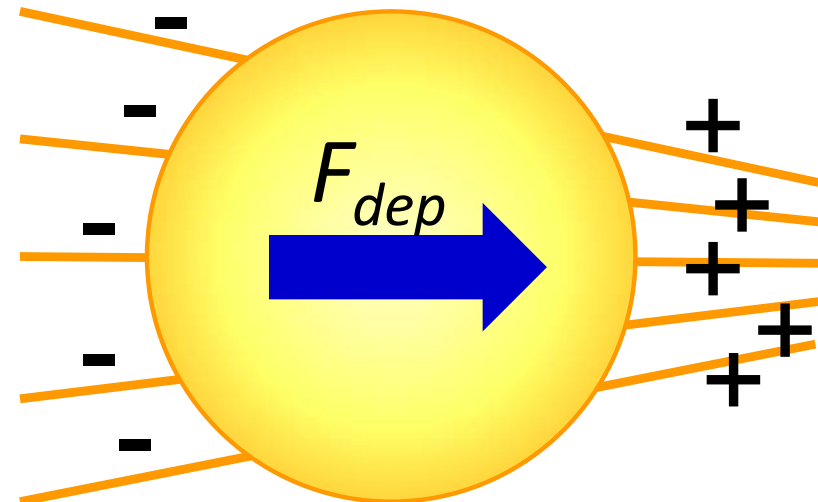
$\epsilon$  Permittivity of object

$\epsilon_s$  Permittivity of solution

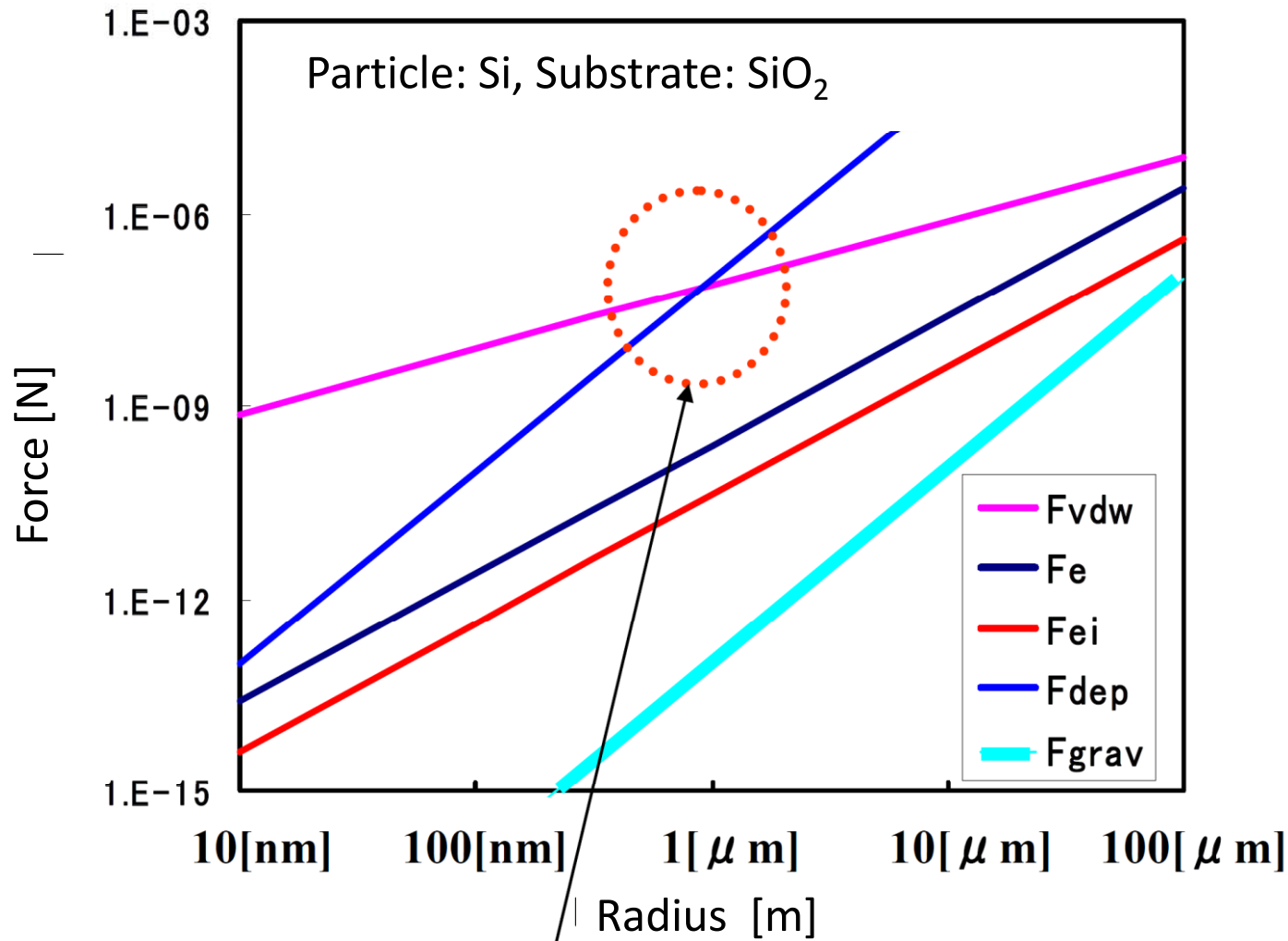
$E = \text{constant}$



$E \neq \text{constant}$



# Comparisons of interaction forces (Analytical)



Parameters

$$H=14.8 \times 10^{-20} \text{ [J]}$$

$$\rho=2300 \text{ [kg/m}^3\text{]}$$

$$z=0.4 \text{ [nm]}$$

$$k= 2.0 \times 10^{-10} \text{ [m}^2\text{/N]}$$

$$\sigma=26.5 \text{ [mC/m}^2\text{]}$$

$$V_c=0.3 \text{ [V]}$$

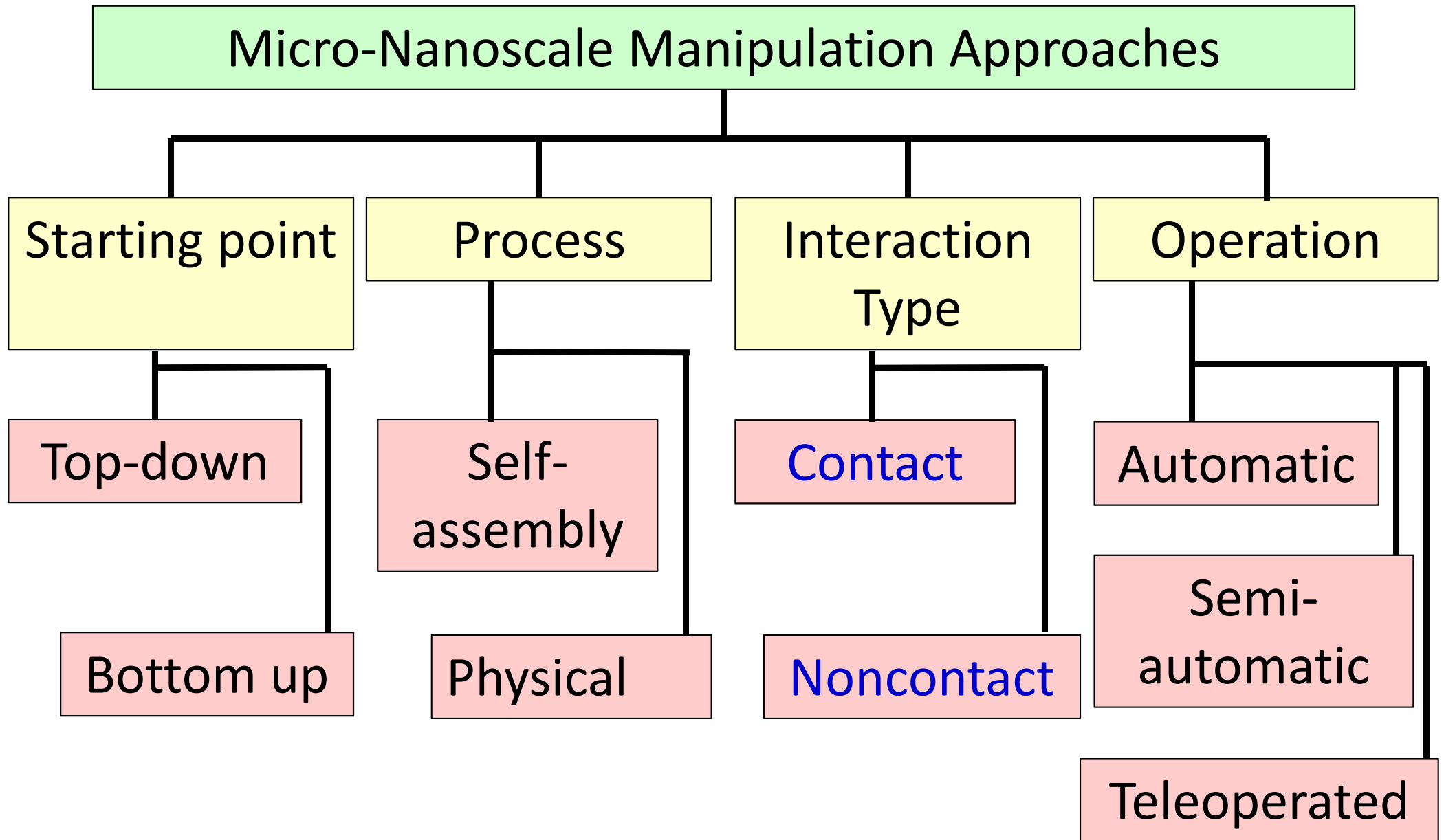
$$\epsilon_0=8.85 \times 10^{-12} \text{ [F/m]}$$

$$\epsilon=5\epsilon_0$$

Radius < 1 μm

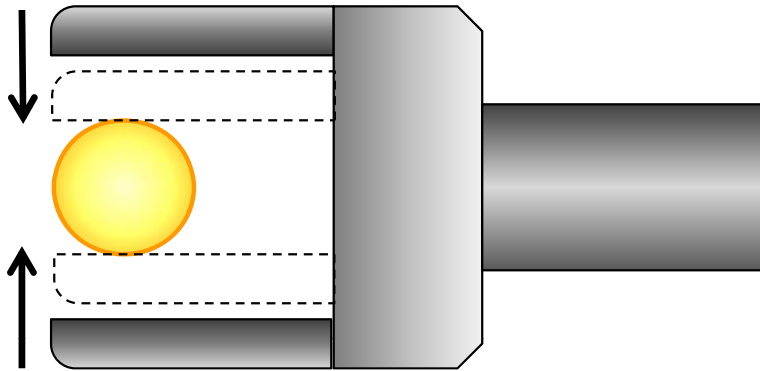
Van der Waals force is bigger than other forces.

# Grouping of Micro-Nano Manipulation

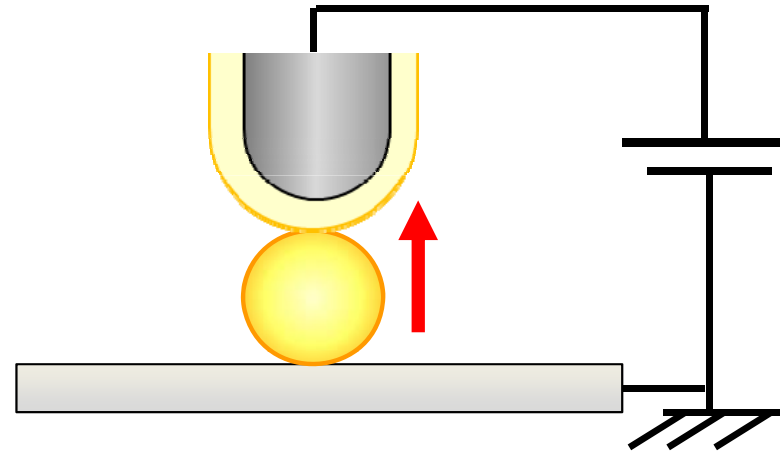


# Contact Manipulation: Gripper/Grasping

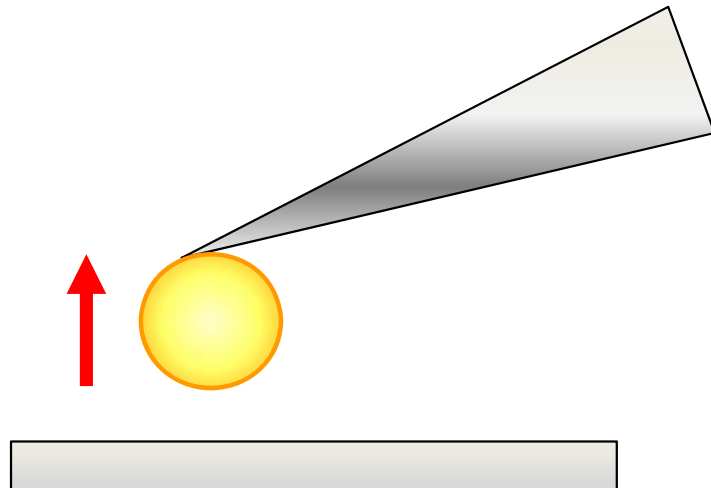
(a) Mechanical gripper



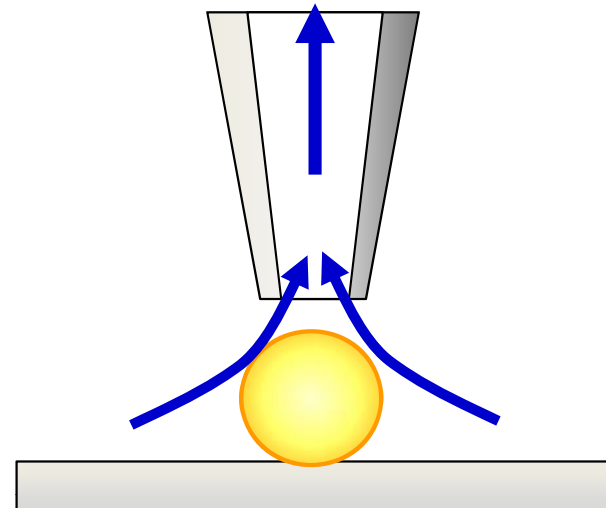
(b) Electrostatic gripper



(c) Wan der waals gripper

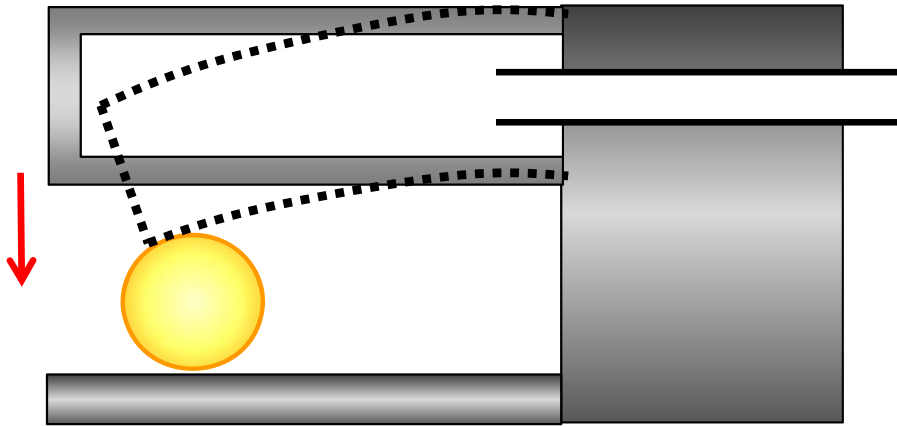


(d) Suction gripper

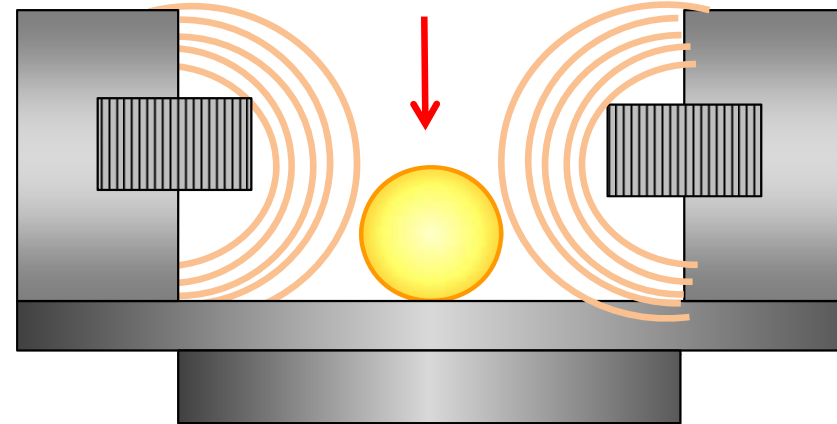


# Contact Manipulation: Gripper/Grasping

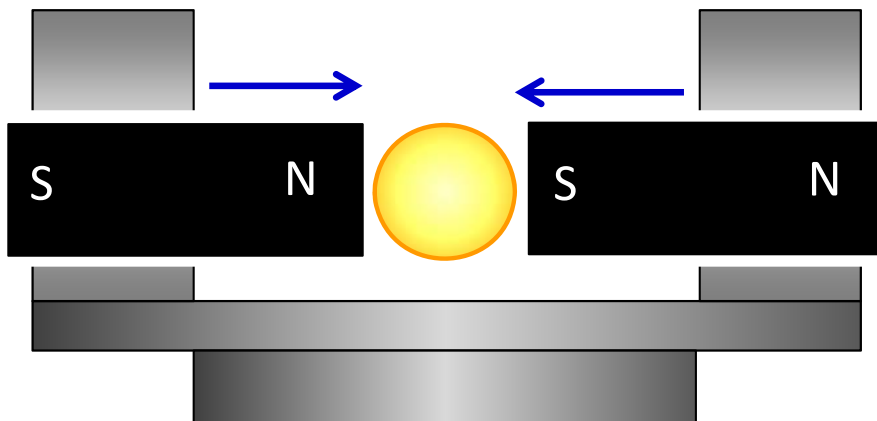
(e) Pneumatic gripper



(f) Wave pressure gripper



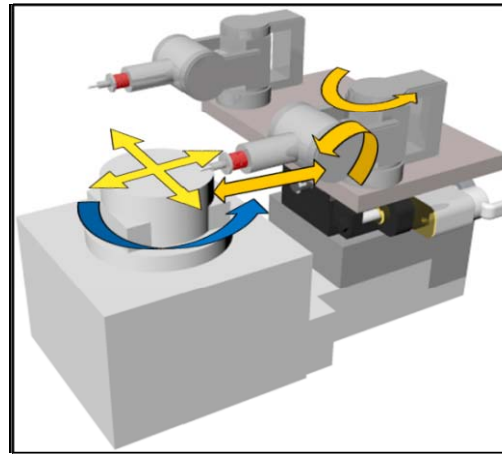
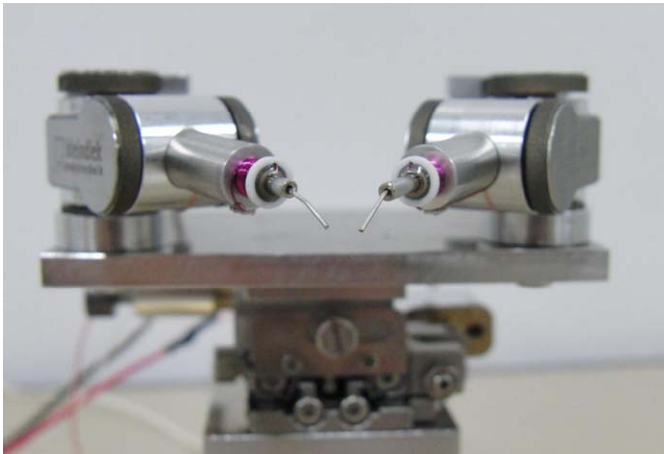
(g) Magnetic gripper





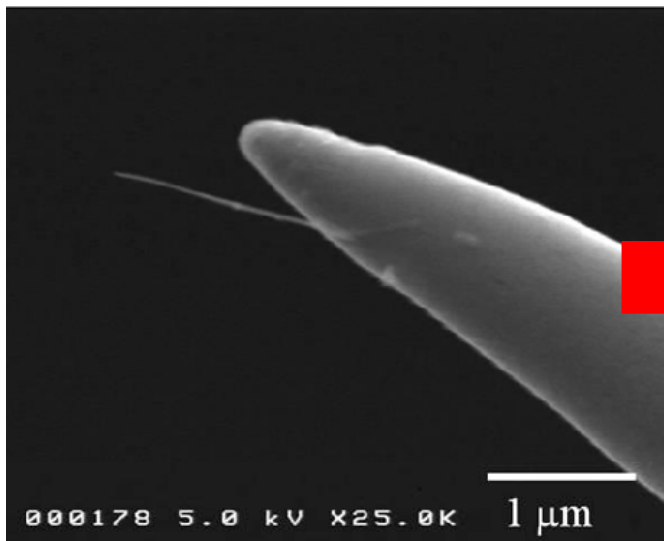
# Wan der Waals Gripper (F. Arai, 2009)

## 12-DOF nanomanipulation system

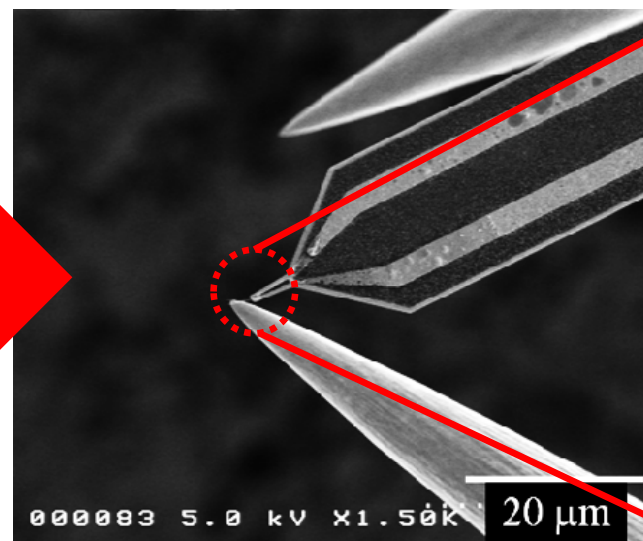


Positioning resolution  
Pitch:  $10^{-7}$  rad ( 5 nm)  
Roll:  $10^{-7}$  rad (3.5 nm)  
Extension: 0.25 nm

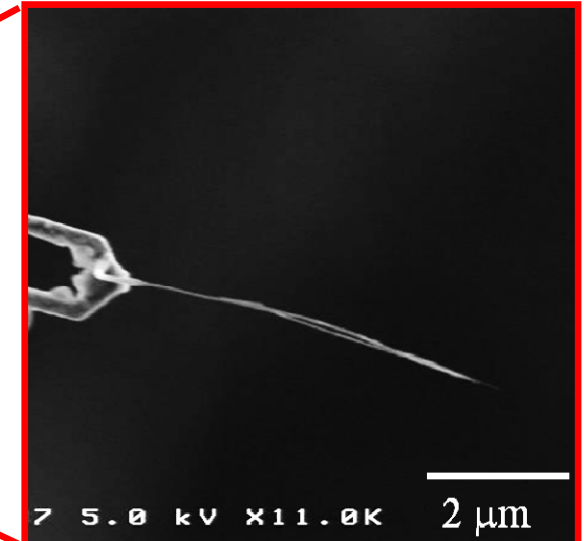
## Nanoassembly of single CNT



Pick up of CNT



Connection to cantilever



Assembled CNT

F. Arai et. al., *IEEE NANO 2009*, 2009.

# Non-Contact Manipulation: Optical Tweezers

## Trapping force by optical tweezers

$$F = Q \frac{nP}{c}$$

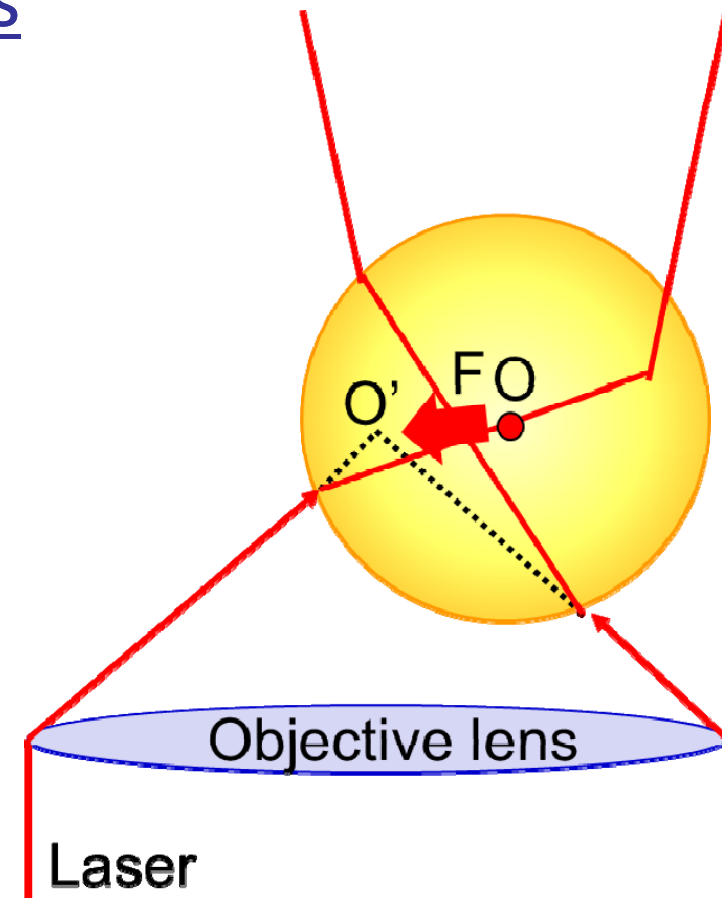
$F$  : Trapping force [N]

$Q$  : Trapping efficiency

$n$  : Relative Refractive index

$P$  : Light power [mW]

$c$  : Light speed  $3 \times 10^8$ [m/s]

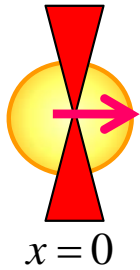


Target size:

From tens of nm to tens of  $\mu\text{m}$

Ashkin A, et al,  
*Optics Letters*, 1986

# Stability Condition of Time Shared Scanning



Settling Time : Minimum Time

Dynamics of Trapped Object

$$6\pi\eta r\dot{x} + Kx = 0$$

Brownian region of trapped beads

$$d_K = \sqrt{\frac{k_B T}{K}}$$

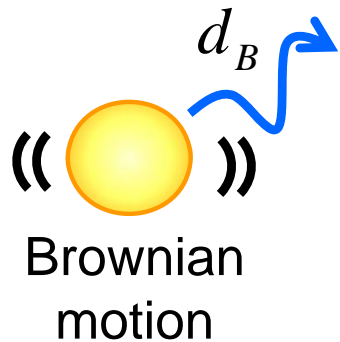
Stability Condition 1: →

$$t_d \geq \frac{6\pi\eta r}{K} \ln \left( d_i \sqrt{\frac{K}{k_B T}} \right)$$

Free Time : Maximum Time

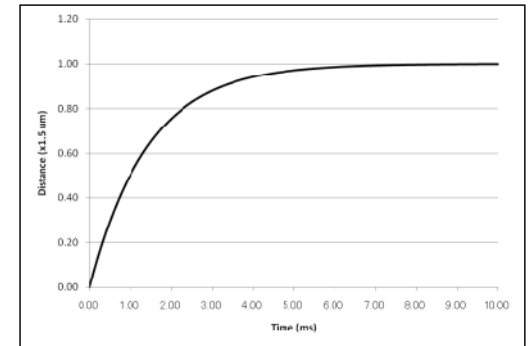
Total displacement by Brownian motion

$$d_t = d_B + d_k = \underbrace{\sqrt{\frac{k_B T \{ (n-1)t_d + nt_m \}}{3\pi\eta r}}}_{\text{Non-trapped}} + \underbrace{\sqrt{\frac{k_B T}{K}}}_{\text{Trapped}}$$



Stability Condition 2: →

$$t_d \leq \frac{1}{n-1} \left\{ \frac{3\pi\eta r}{k_B T} \left( \frac{0.61\lambda}{N.A.} - \sqrt{\frac{k_B T}{K}} \right)^2 - nt_m \right\}$$

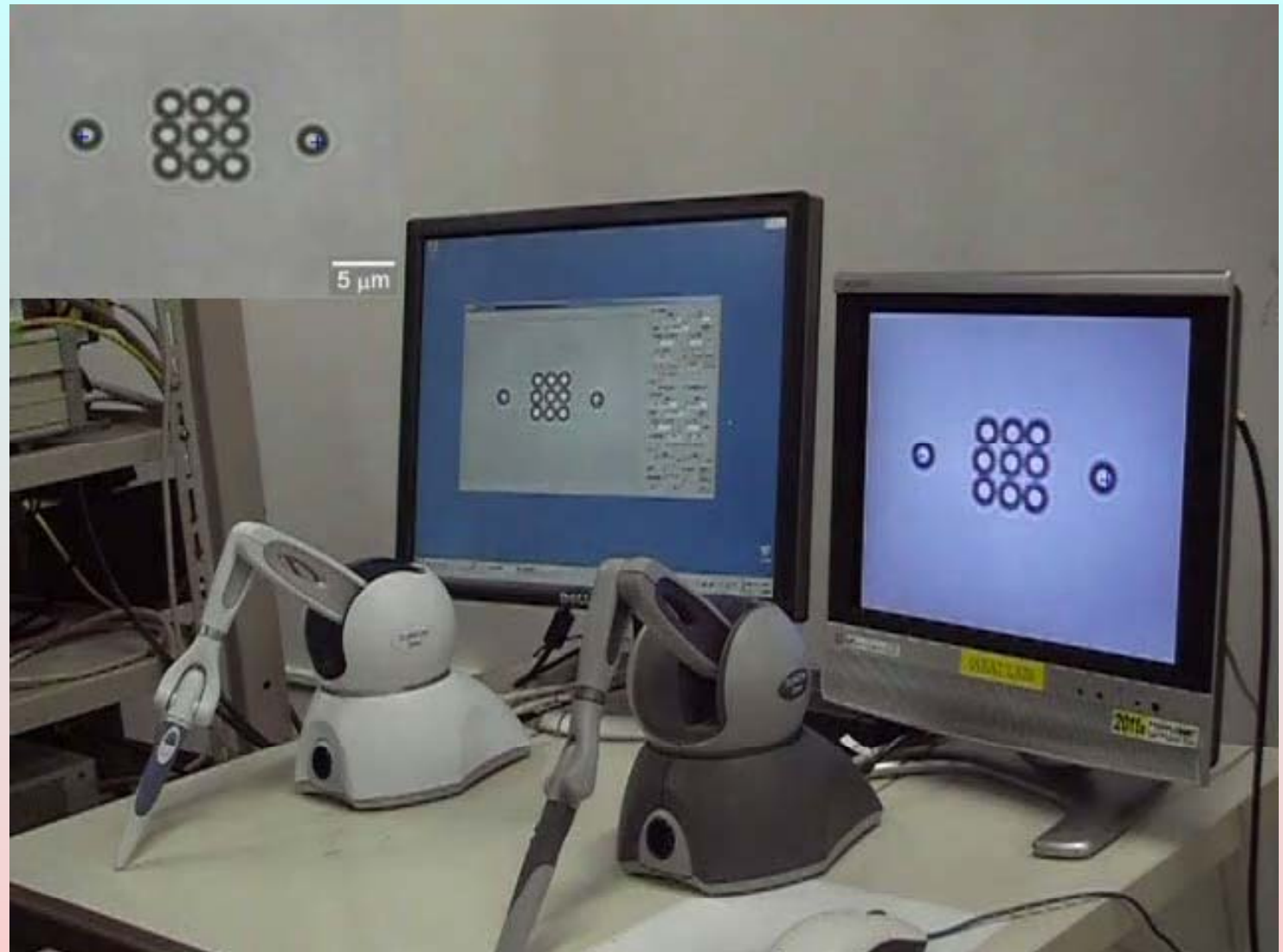
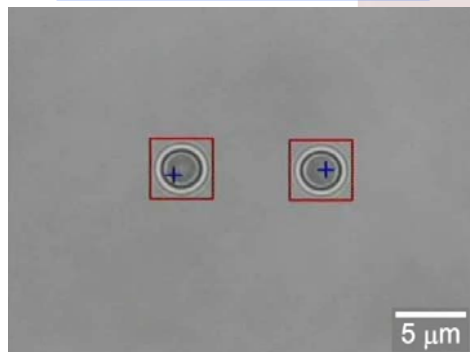
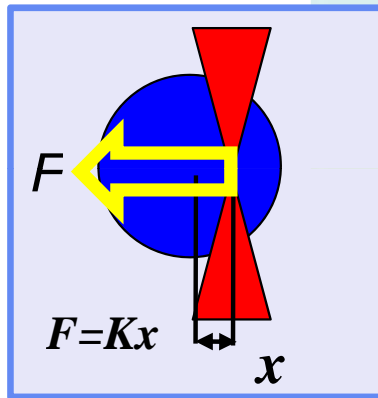
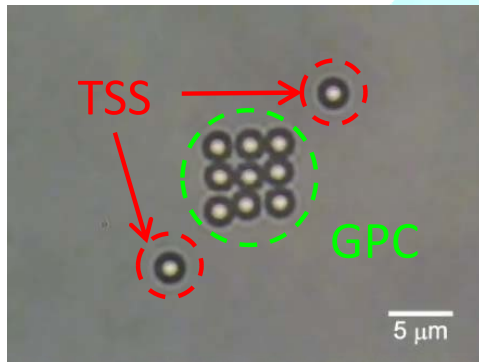


Step response of object

F. Arai et. al., *APL*, 85-19, 2004



# Optical Particle Manipulation (F. Arai, 2009)



**Force feedback**

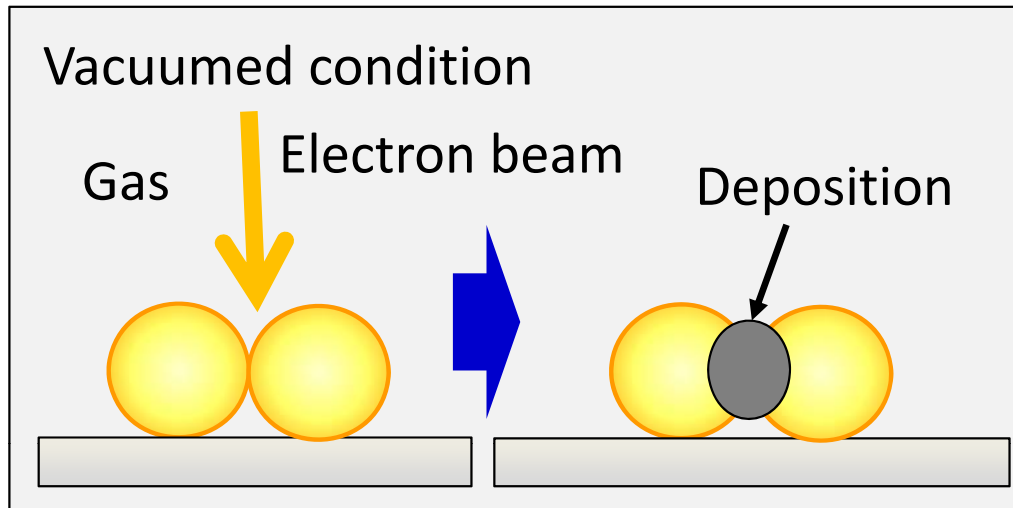
Force is measured by image processing.

**F. Arai et. al., ICRA2009, 2009.**

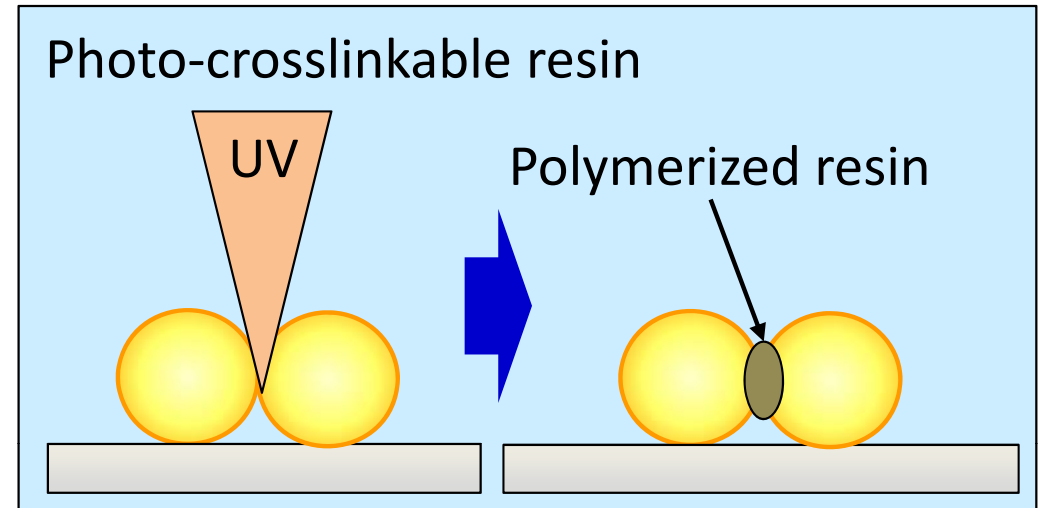


# Micro-Nano Assembly: Connection

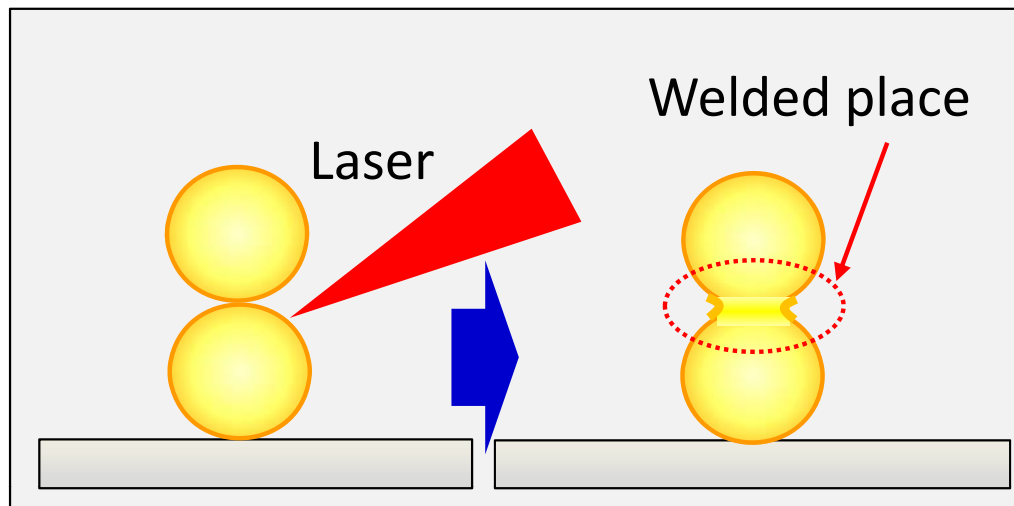
(a) Deposition method



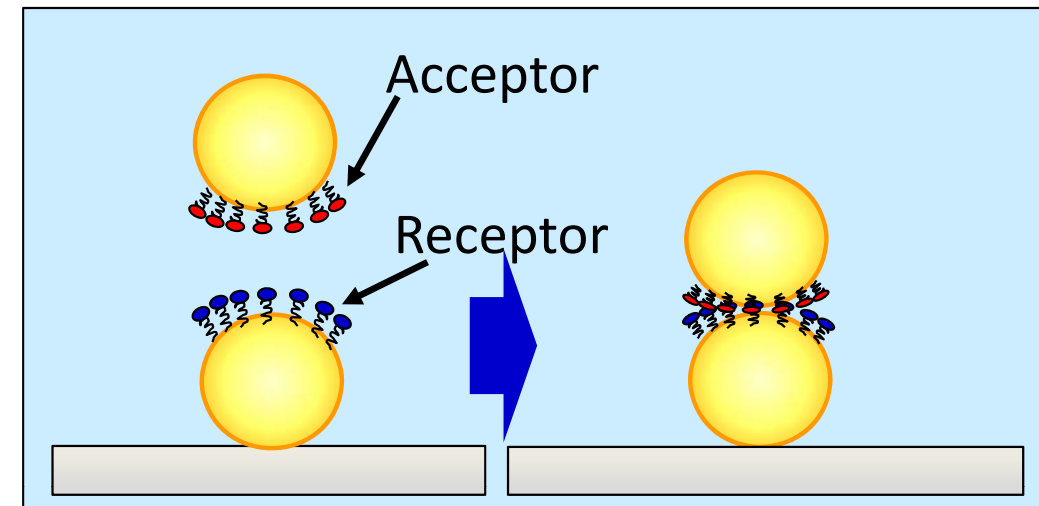
(b) Local photopolymerization



(c) Laser ablation



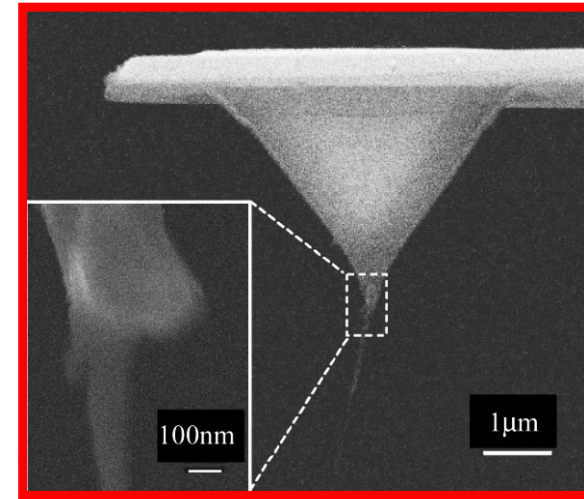
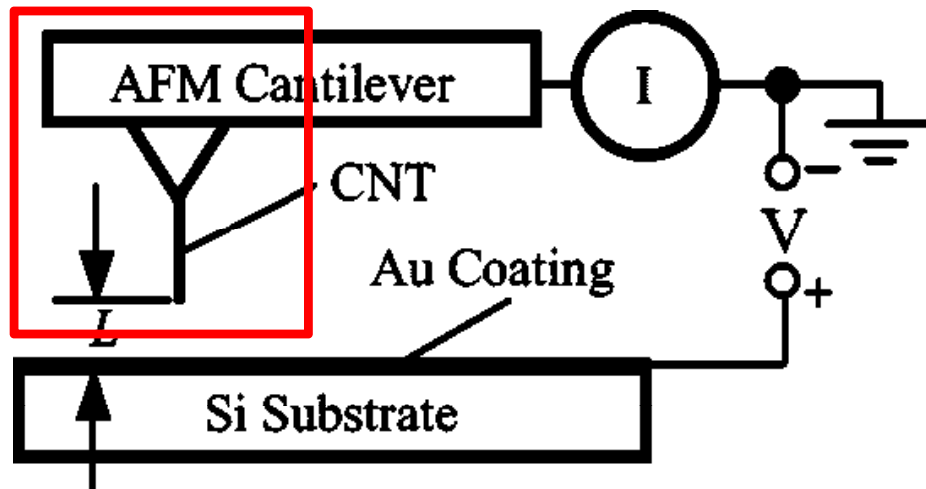
(d) Chemical bonding





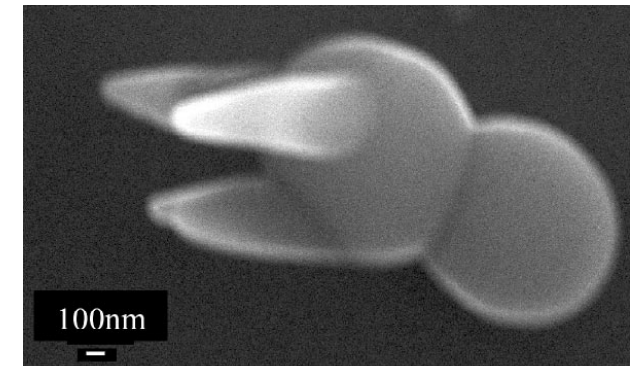
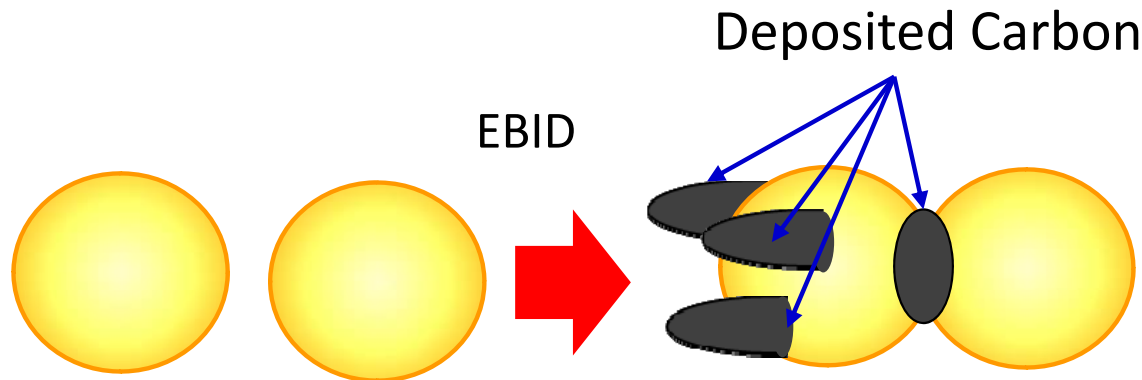
# Connection: Electron Beam Induced Depositi

## Assemble of CNT emitter by EBID



CNT connected cantirever (CNT-emitter)

## Assemble of microhand by EBID

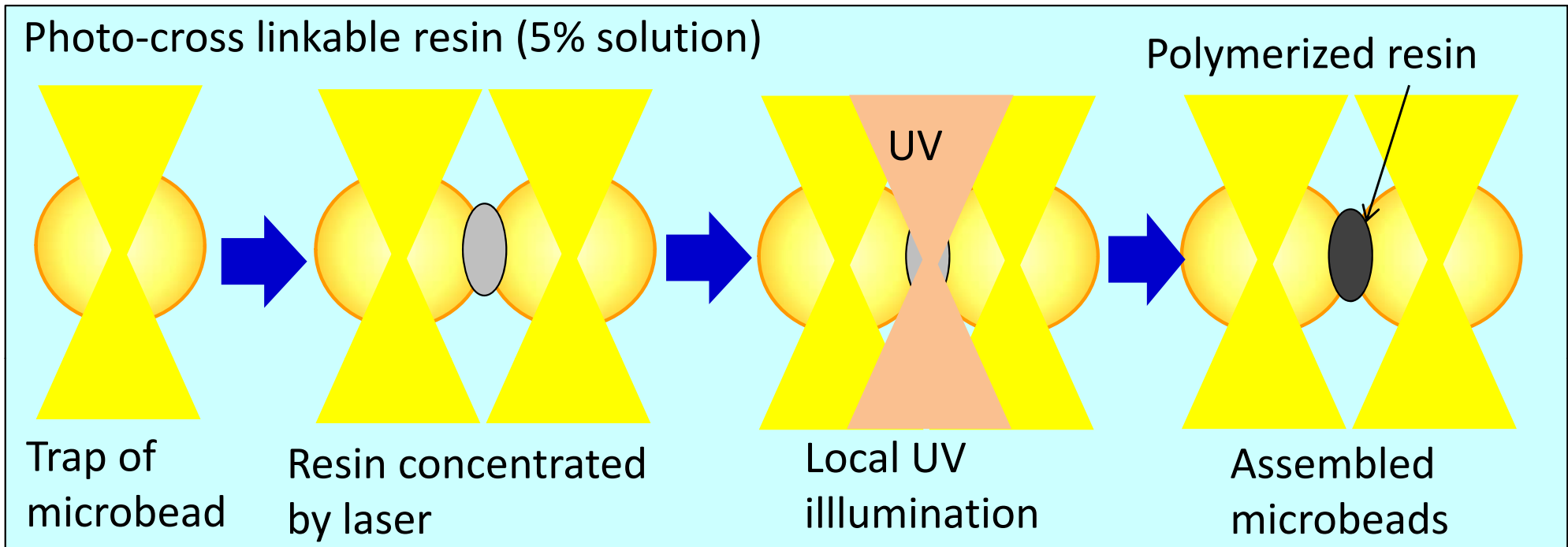


Microhand assemble by EBID

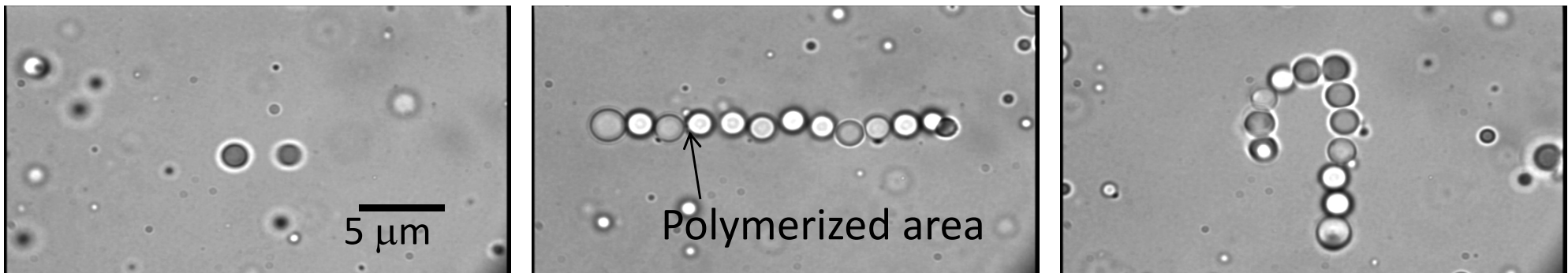
L. Dong, F. Arai, T. Fukuda, APL, 81, 1919-1921, 2002

# Connection: Local Photo Polymerization

## In-situ assembly by local photo polymerization



## Assembly of rope-like microtool



H. Maruyama, F. Arai, T. Fukuda, JRM, 17, 335-341, 2005

31



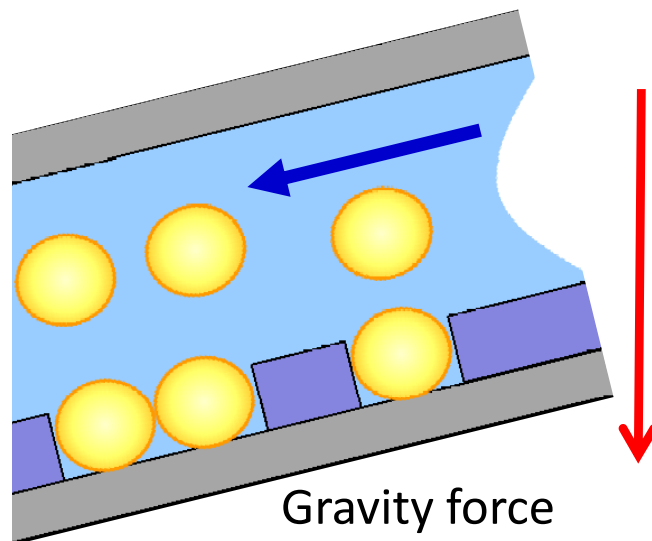
# Micro-Nano Assembly: Self-assembly

**Self-assembly:** Nanofabrication technique that involve aggregation of colloidal particles into final desired structure.

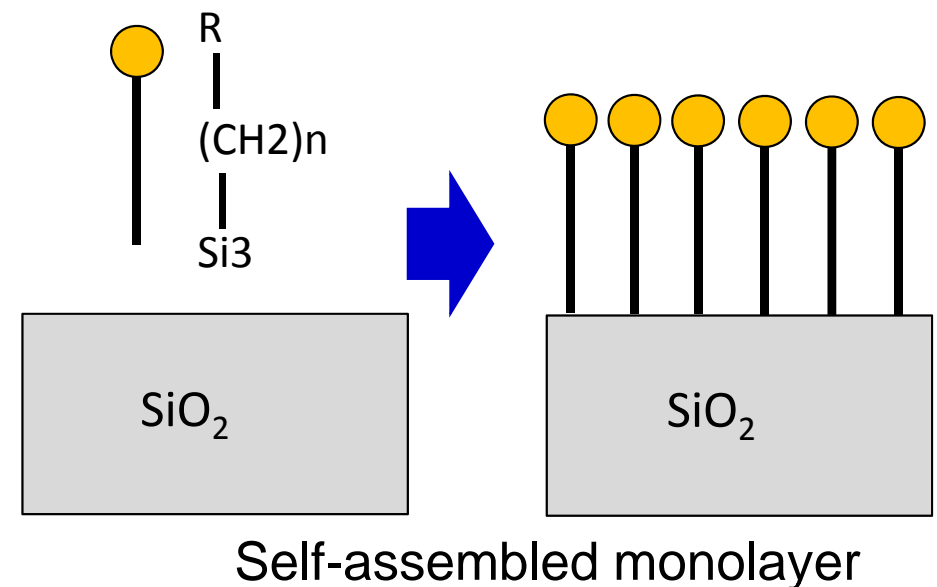
G.M. Whitesides, 2002

## Classification of self-assembly

### 1. Physical assembly



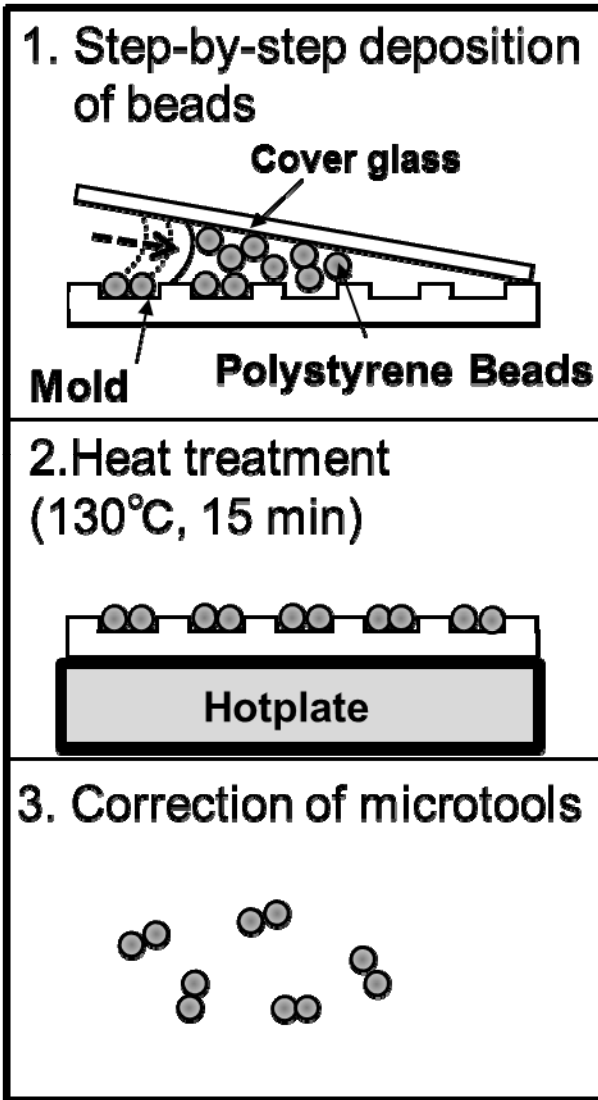
### 2. Chemical assembly



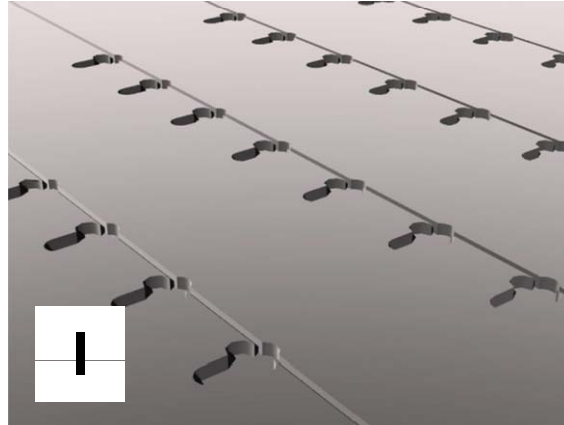


# Physical self-assembly with Template

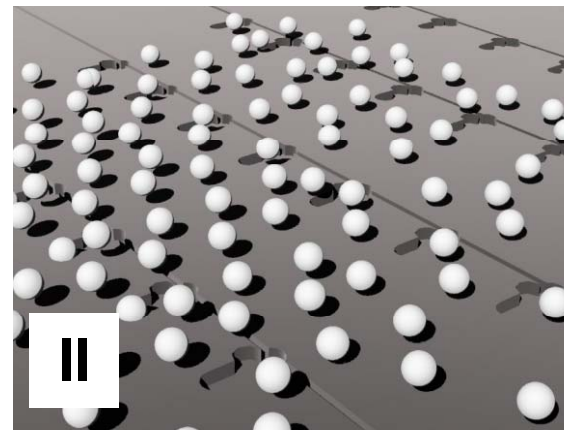
Assemble process by template-based self-assembly



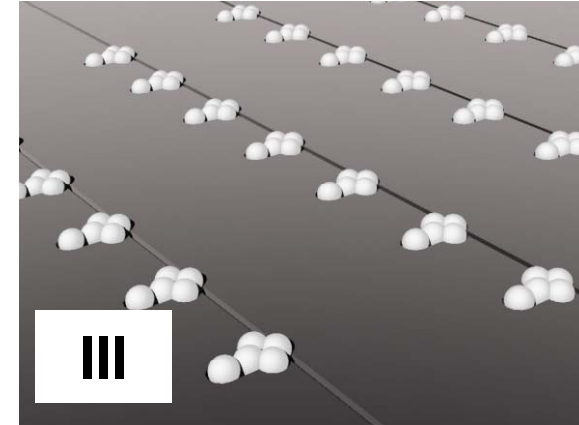
I. Mold fabrication



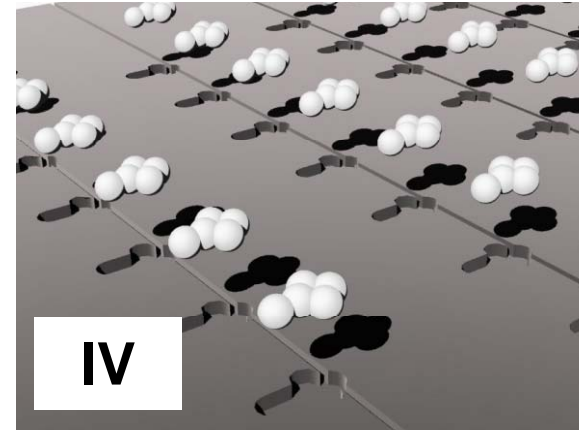
II. Bead injection



III. Bead patterning



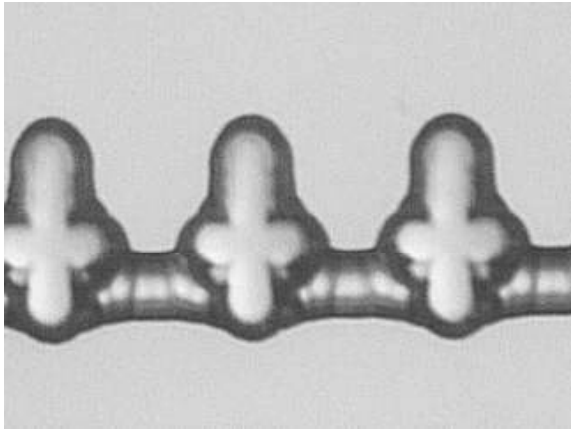
III. Heat connection



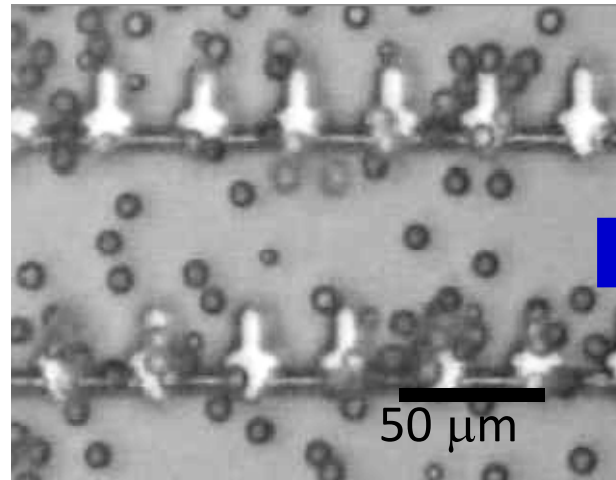
H. Maruyama, et. al., JRM, 22, pp.356-362, 2010.

# Assemble results: Step-by-step deposition of beads

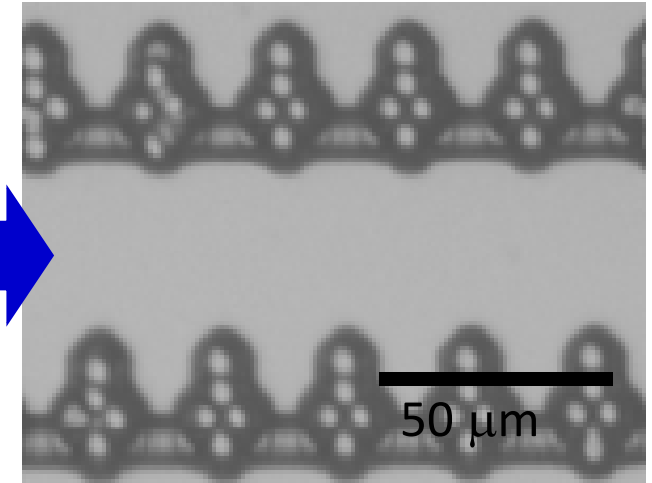
## Assembly of cross-shape microtool



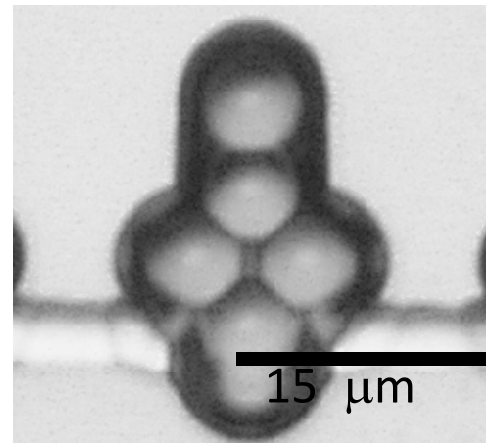
Template (Si)



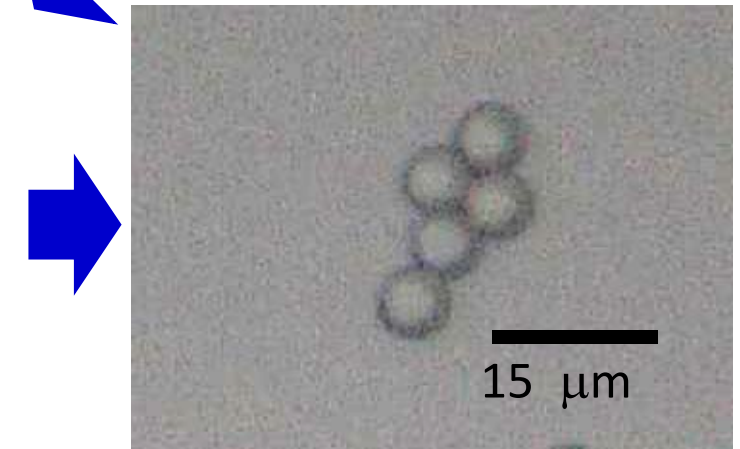
Bead injection



Patterned beads



After Heat connection



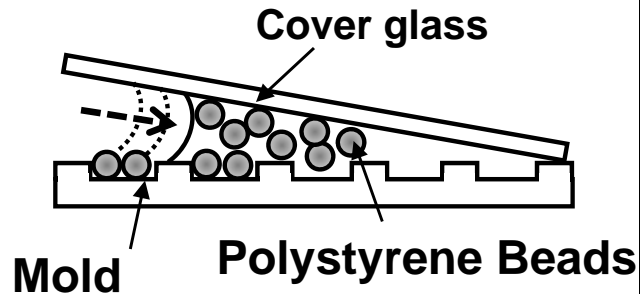
Released tool

### Employed forces:

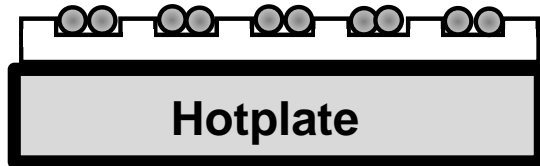
1. Gravity force  
Bead injection into template
2. Liquid bridge force  
Alignment of bead inside template

# Assemble results: Connection by heat treatment

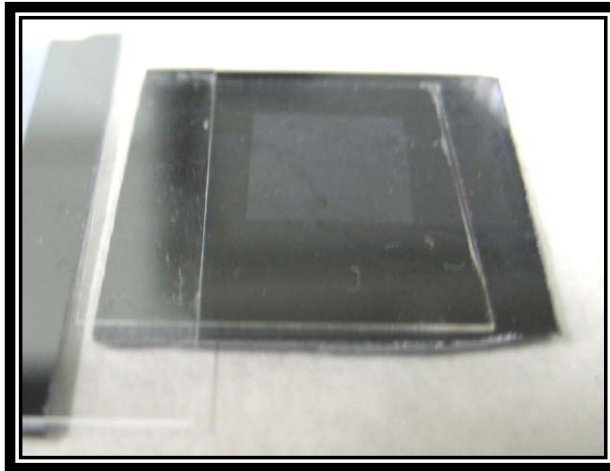
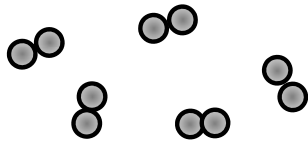
1. Step-by-step deposition of beads



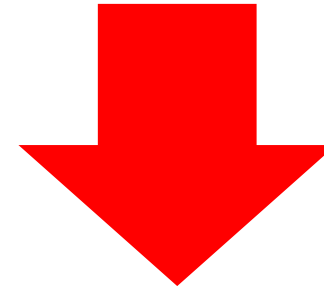
2. Heat treatment  
(130°C, 15 min)



3. Correction of microtools

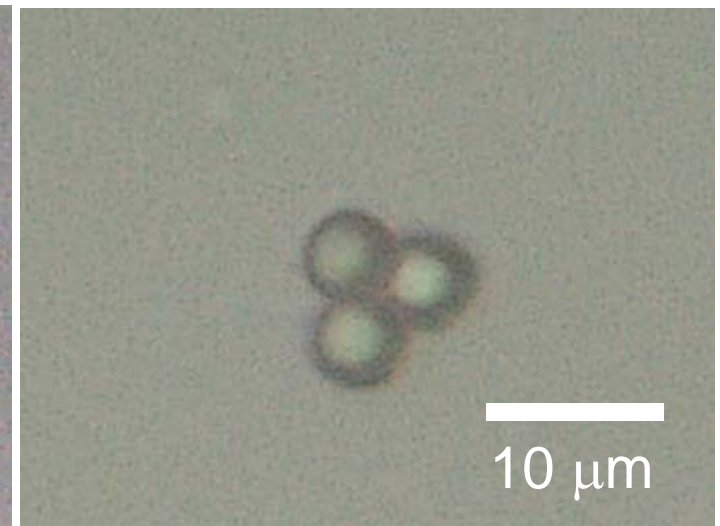
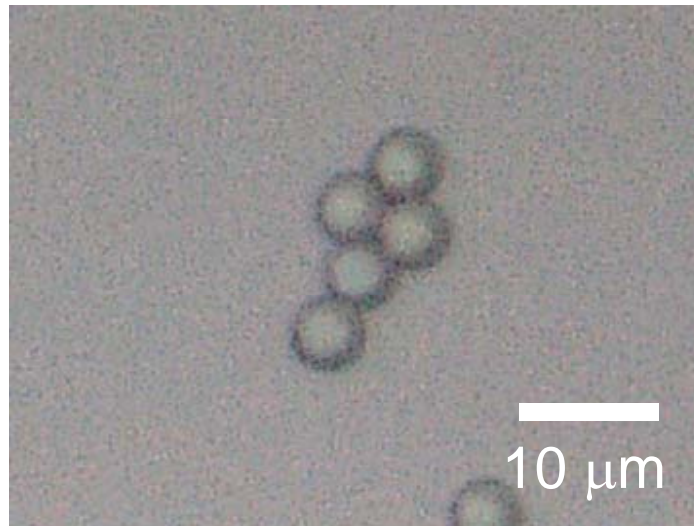


Remove from mold after heat treatment



Cross shape microtools

Triangle shape microtool



# Summary

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## Conclusion:

**Interaction force** is most important parameters for micro-nano assembly process such as manipulation, connection, and self-assembly.

Self-assembly is promising technique due to its low cost and the ability of to produce structures from micro to nano scales

## Future direction of micro-nano assembly:

1. Fusion of top down and bottom up approaches
2. Molecular self-assembly

Requirement of precious molecular design

# References

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1. Naoki Inomata, Takahiro Kato and Fumihito Arai, "Evaluation of Thermal Conduction of Single Carbon Nanotube by Local Heating in Air", 2009 9th IEEE Conference on Nanotechnology, July 26-30, Italy (2009) pp. 112-115.
2. F. Arai, K. Yoshikawa, T. Sakami, and T. Fukuda, "Synchronized laser micromanipulation of multiple targets along each trajectory by single laser," Applied Physics Letters, 85, 4301-4303 (2004).
3. Fumihito Arai, Kazuhisa Onda, Ryo Iitsuka, and Hisataka Maruyama, "Multi-beam Laser Micromanipulation of Microtool by Integrated Optical Tweezers," Proc. of ICRA2009, pp. 1832-1837, 2009.
4. Lixin Dong, Fumihito Arai, and Toshio Fukuda, "Electron-beam-induced deposition with carbon nanotube emitters," Appl. Phys. Lett., 81, pp. 1919-1921
5. H. Maruyama, F. Arai, T. Fukuda, "Microfabrication and Laser Manipulation of Functional Microtool using In-Situ photofabrication," Journal of Robotics and Mechatronics, Vol. 17, No.3, (2005), pp.335-341.
6. H. Maruyama, R. Iitsuka, K. Onda, F. Arai, "Massive Parallel Assembly of Microbeads for Fabrication of Microtools Having Spherical Structure and Powerful Manipulation by Optical Tweezers," Journal of Robotics and Mechatronics, Vol. 22, no. 3, (2010), pp.356-362.

